

# DATA SHEET



**PCF8531**

**34 × 128 pixel matrix driver**

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**34 × 128 pixel matrix driver****PCF8531**

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## 34 × 128 pixel matrix driver

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**1 FEATURES**

- Single-chip LCD controller/driver
- 34 row and 128 column outputs
- Display data RAM 34 × 128 bits
- 128 icons (last row is used for icons)
- Fast mode I<sup>2</sup>C-bus interface (400 kbit/s)
- Software selectable multiplex rates: 1 : 17, 1 : 26 and 1 : 34
- Icon mode with Mux rate 1 : 2:
  - Featuring reduced current consumption while displaying icons only.
- On-chip:
  - Generation of V<sub>LCD</sub> (external supply also possible)
  - Selectable linear temperature compensation
  - Oscillator requires no external components (external clock also possible)
  - Generation of intermediate LCD bias voltages
  - Power-on reset.
- No external components required
- Software selectable bias configuration
- Logic supply voltage range V<sub>DD1</sub> to V<sub>SS1</sub> 1.8 to 5.5 V
- Supply voltage range for on-chip voltage generator V<sub>DD2</sub> and V<sub>DD3</sub> to V<sub>SS1</sub> and V<sub>SS2</sub> 2.5 to 4.5 V
- Display supply voltage range V<sub>LCD</sub> to V<sub>SS</sub>:
  - Normal mode 4 to 9 V
  - Icon mode 3 to 9 V.
- Low power consumption, suitable for battery operated systems
- CMOS compatible inputs
- Manufactured in silicon gate CMOS process.

**2 APPLICATIONS**

- Telecommunication systems
- Automotive information systems
- Point-of-sale terminals
- Instrumentation.

**3 GENERAL DESCRIPTION**

The PCF8531 is a low power CMOS LCD row/column driver, designed to drive dot matrix graphic displays at multiplex rates of 1 : 17, 1 : 26 and 1 : 34. Furthermore, it can drive up to 128 icons. All necessary functions for the display are provided in a single chip, including on-chip generation of V<sub>LCD</sub> and the LCD bias voltages, resulting in a minimum of external components and low power consumption. The PCF8531 is compatible with most microcontrollers and communicates via a two-line bidirectional bus (I<sup>2</sup>C-bus). All inputs are CMOS compatible.

**Remark:** The icon mode is used to save current. When only icons are displayed, a much lower operating voltage (V<sub>LCD</sub>) can be used and the switching frequency of the LCD outputs is reduced. In most applications it is possible to use V<sub>DD</sub> as V<sub>LCD</sub>.

**4 PACKAGES**

The PCF8531 is available as chip with bumps in tray.

**5 ORDERING INFORMATION**

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PCF8531U/2	–	chip with bumps in tray	–

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6 BLOCK DIAGRAM

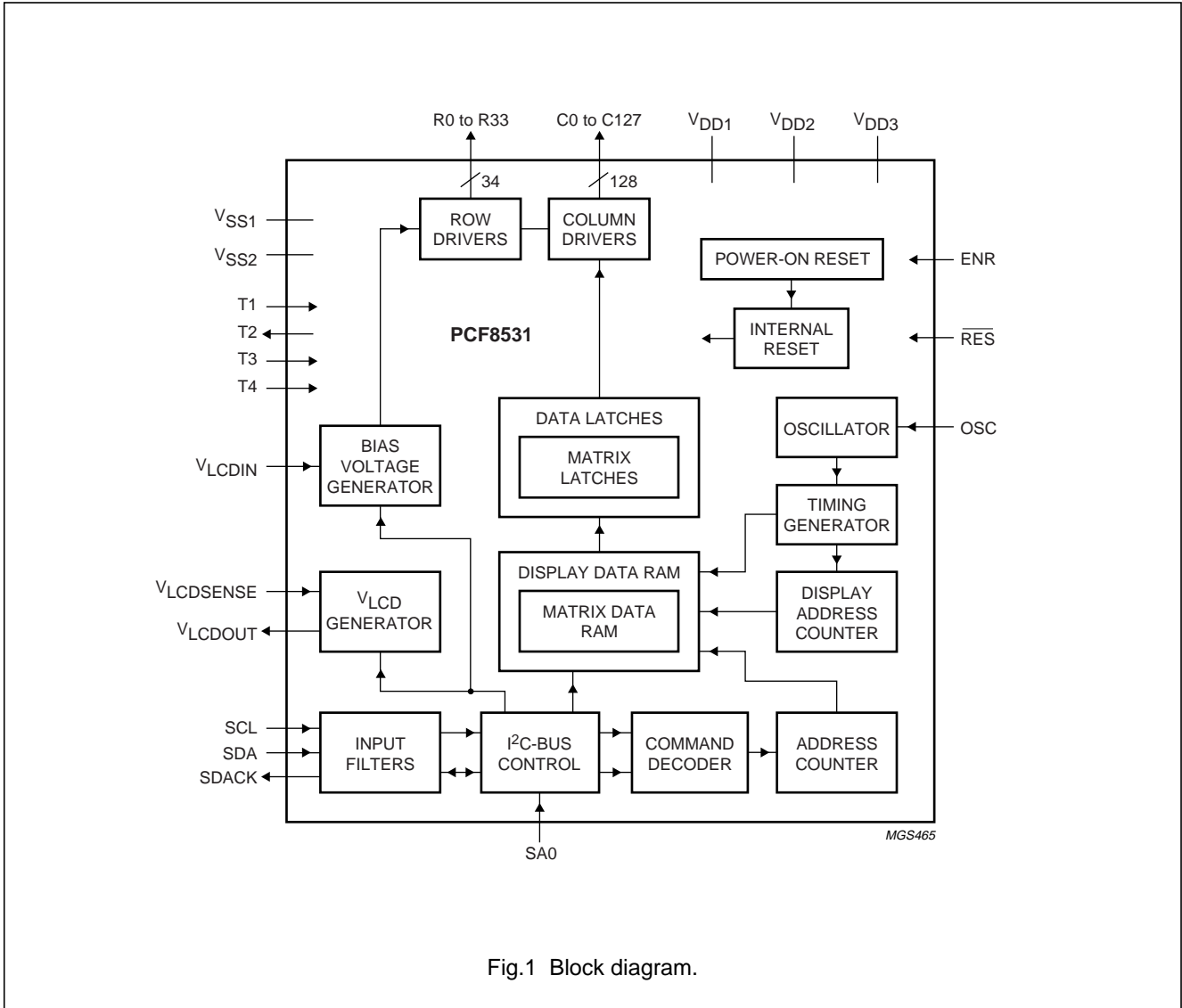


Fig.1 Block diagram.

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## 7 PINNING

SYMBOL	PAD	DESCRIPTION
	1 to 14	dummy pads
OSC	15	oscillator input; note 1
V <sub>LCDSSENSE</sub>	16	voltage multiplier regulation input (V <sub>LCD</sub> ); note 2
V <sub>LCDOUT</sub>	17 to 23	voltage multiplier output (V <sub>LCD</sub> ); note 3
V <sub>LCDIN</sub>	24 to 30	LCD supply voltage (V <sub>LCD</sub> ); note 2
RES	31	external reset input (active LOW); note 4
V <sub>DD3</sub>	32 to 34	supply voltage 3; note 5
V <sub>DD2</sub>	35 to 42	supply voltage 2; note 5
V <sub>DD1</sub>	43 to 49	supply voltage 1; note 5
SDA	50 and 51	serial data line input of the I <sup>2</sup> C-bus
SDACK	52	serial data acknowledge output; note 6
	53	dummy pad
SA0	54	I <sup>2</sup> C-bus slave address input; bit 0
ENR	55	enable internal Power-on reset input; note 7
T4	56	test 4 input; note 8
V <sub>SS2</sub>	57 to 63	ground 2; note 9
V <sub>SS1</sub>	64 to 70	ground 1; note 9
T3	71	test 3 input; note 8
T1	72	test 1 input; note 8
SCL	73 and 74	serial clock line input of the I <sup>2</sup> C-bus
	75 to 77	dummy pads
T2	78	test 2 output; note 10
	79 to 86	dummy pads
R0	87	LCD row driver output
R2	88	LCD row driver output
R4	89	LCD row driver output
R6	90	LCD row driver output
R8	91	LCD row driver output
R10	92	LCD row driver output
R12	93	LCD row driver output
R14	94	LCD row driver output
R16	95	LCD row driver output
R18	96	LCD row driver output
R20	97	LCD row driver output
R22	98	LCD row driver output
R24	99	LCD row driver output
R26	100	LCD row driver output
R28	101	LCD row driver output
R30	102	LCD row driver output
R32	103	LCD row driver output

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SYMBOL	PAD	DESCRIPTION
C0 to C127	104 to 231	LCD column driver outputs
R33	232	LCD row driver output; icon row
R31	233	LCD row driver output
R29	234	LCD row driver output
R27	235	LCD row driver output
R25	236	LCD row driver output
R23	237	LCD row driver output
R21	238	LCD row driver output
R19	239	LCD row driver output
R17	240	LCD row driver output
R15	241	LCD row driver output
R13	242	LCD row driver output
R11	243	LCD row driver output
R9	244	LCD row driver output
R7	245	LCD row driver output
R5	246	LCD row driver output
R3	247	LCD row driver output
R1	248	LCD row driver output

**Notes**

1. If the on-chip oscillator is used, this input must be connected to  $V_{DD1}$ .
2. If the internal  $V_{LCD}$  generation is used,  $V_{LCDOUT}$ ,  $V_{LCDIN}$  and  $V_{LCDSENSE}$  must be connected together.
3. If an external  $V_{LCD}$  is used in the application, then pin  $V_{LCDOUT}$  must be left open circuit, otherwise the chip will be damaged.
4. If only the internal Power-on reset is used, this input must be connected to  $V_{DD1}$ .
5.  $V_{DD1}$  is for the logic supply,  $V_{DD2}$ , and  $V_{DD3}$  are for the voltage multiplier. For split power supplies,  $V_{DD2}$  and  $V_{DD3}$  must be connected together. If only one supply voltage is available,  $V_{DD1}$ ,  $V_{DD2}$  and  $V_{DD3}$  must be connected together.
6. Serial data acknowledge for the I<sup>2</sup>C-bus. By connecting  $SDACK$  to  $SDA$  externally, the  $SDA$  line becomes fully I<sup>2</sup>C-bus compatible. Having the acknowledge output separated from the serial data line is advantageous in Chip-On-Glass (COG) applications. In COG applications where the track resistance from the  $SDACK$  pad to the system  $SDA$  line can be significant, a potential divider is generated by the bus pull-up resistor and the Indium Tin Oxide (ITO) track resistance. It is possible that the PCF8531 will not be able to create a valid logic 0 level during the acknowledge cycle. By splitting the  $SDA$  input from the  $SDACK$  output, the device could be used in a mode that ignores the acknowledge bit. In COG applications where the acknowledge cycle is required, it is necessary to minimize the track resistance from the  $SDACK$  pad to the system  $SDA$  line to guarantee a valid LOW level.
7. If  $ENR$  is connected to  $V_{SS}$ , Power-on reset is disabled; to enable Power-on reset  $ENR$  should be connected to  $V_{DD1}$ .
8. In the application, this input must be connected to  $V_{SS}$ .
9.  $V_{SS1}$  and  $V_{SS2}$  must be connected together.
10. In the application,  $T2$  must be left open circuit.

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**8 FUNCTIONAL DESCRIPTION****8.1 Oscillator**

The on-chip oscillator provides the clock signal for the display system. No external components are required and the OSC input must be connected to  $V_{DD}$ . An external clock signal, if used, is connected to this input.

**8.2 Power-on reset**

The on-chip Power-on reset initializes the chip after Power-on or power failure.

**8.3 I<sup>2</sup>C-bus controller**

The I<sup>2</sup>C-bus controller receives and executes the commands. The PCF8531 acts as an I<sup>2</sup>C-bus slave receiver and therefore cannot control bus communication.

**8.4 Input filters**

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

**8.5 Display data RAM**

The PCF8531 contains a 34 × 128 bits static RAM, which stores the display data. The RAM is divided into 6 banks of 128 bytes (6 × 8 × 128 bits). Bank 6 is used for icon data. During RAM access, data is transferred to the RAM via the I<sup>2</sup>C-bus interface. There is a direct correspondence between the X address and column output number.

**8.6 Timing generator**

The timing generator produces the various signals required to drive the internal circuitry. Internal chip operation is not disturbed by operations on the data buses.

**8.7 Address counter**

The address counter sets the addresses of the display data RAM for writing.

**8.8 Display address counter**

The display address counter generates the addresses for read out of the display data.

**8.9 Command decoder**

The command decoder identifies command words that arrive on the I<sup>2</sup>C-bus and determines the destination for the following data bytes.

**8.10 Bias voltage generator**

The bias voltage generator generates four buffered intermediate bias voltages. This block contains the generator for the reference voltages and the four buffers. This block can operate in two voltage ranges:

- Normal mode; 4.0 to 9.0 V
- Power save mode; 3.0 to 9.0 V.

**8.11 V<sub>LCD</sub> generator**

The  $V_{LCD}$  voltage generator contains a configurable 2 to 5 times voltage multiplier; this is software programmable.

**8.12 Reset**

The PCF8531 has the possibility of two reset modes, internal Power-on reset or external reset ( $\overline{RES}$ ). The reset mode is selected using the ENR signal. After a reset, the chip has the following state:

- All row and column outputs are set to  $V_{SS}$  (display off)
- RAM data is undefined
- Power-down mode.

**8.13 Power-down**

During power-down, all static currents are switched off (no internal oscillator, no timing and no LCD segment drive system), and all LCD outputs are internally connected to  $V_{SS}$ . The I<sup>2</sup>C-bus function remains operational.

**8.14 Column driver outputs**

The LCD drive section includes 128 column outputs (C0 to C127) which should be connected directly to the LCD. The column output signals are generated in accordance with the multiplexed row signals and with the data in the display latch. When less than 128 columns are required, the unused column outputs should be left open circuit.

**8.15 Row driver outputs**

The LCD drive section includes 34 row outputs (R0 to R33), which should be connected directly to the LCD. The row output signals are generated in accordance with the selected LCD drive mode. If less than 34 rows or lower Mux rates are required, the unused outputs must be left open circuit. The row signals are interlaced i.e. the selection order is R0, R2, ..., R1, R3 etc.

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8.16 LCD waveforms and DDRAM to data mapping

The LCD waveforms and the DDRAM to display data mapping are shown in Figs 2, 3 and 4.

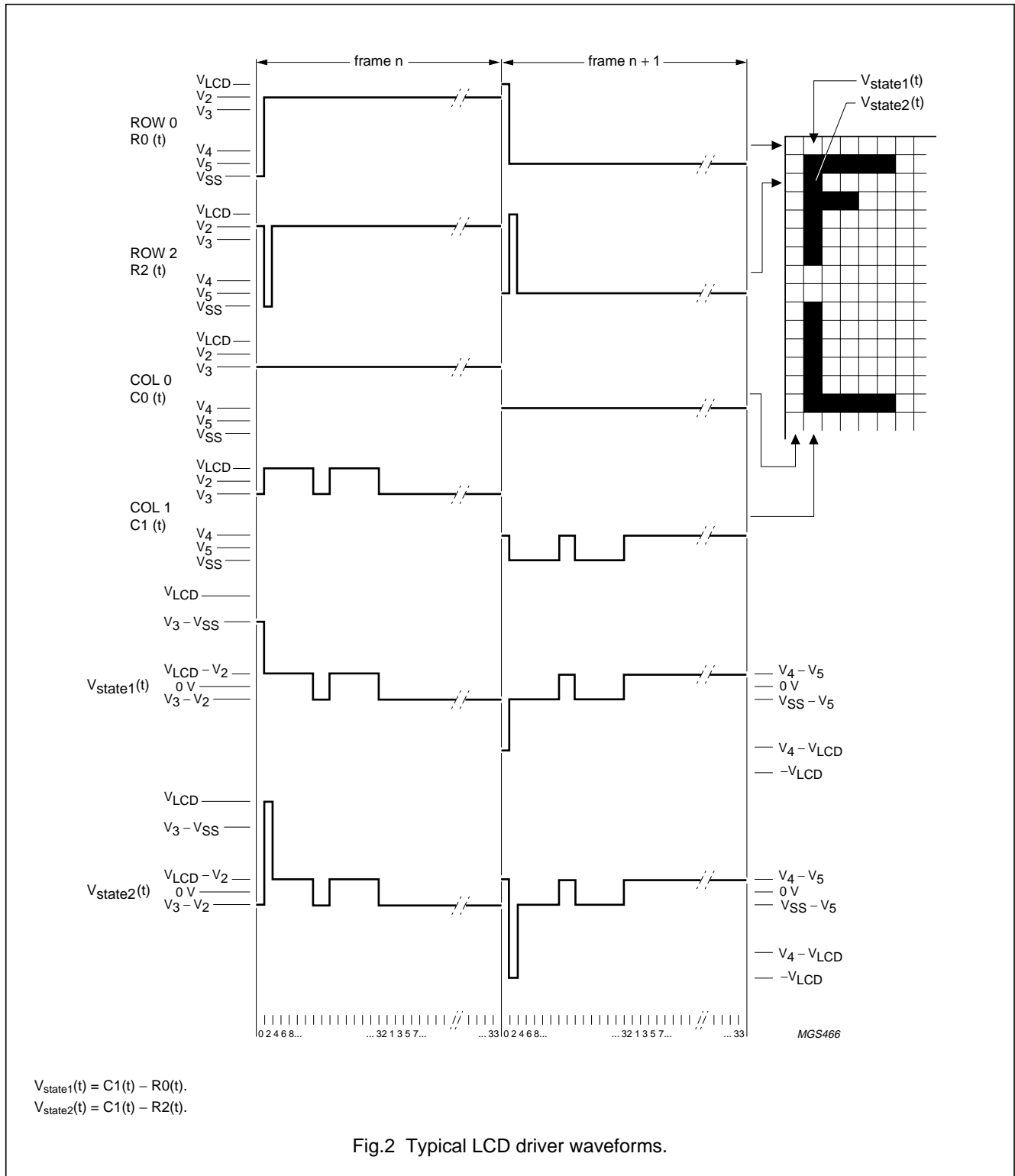


Fig.2 Typical LCD driver waveforms.



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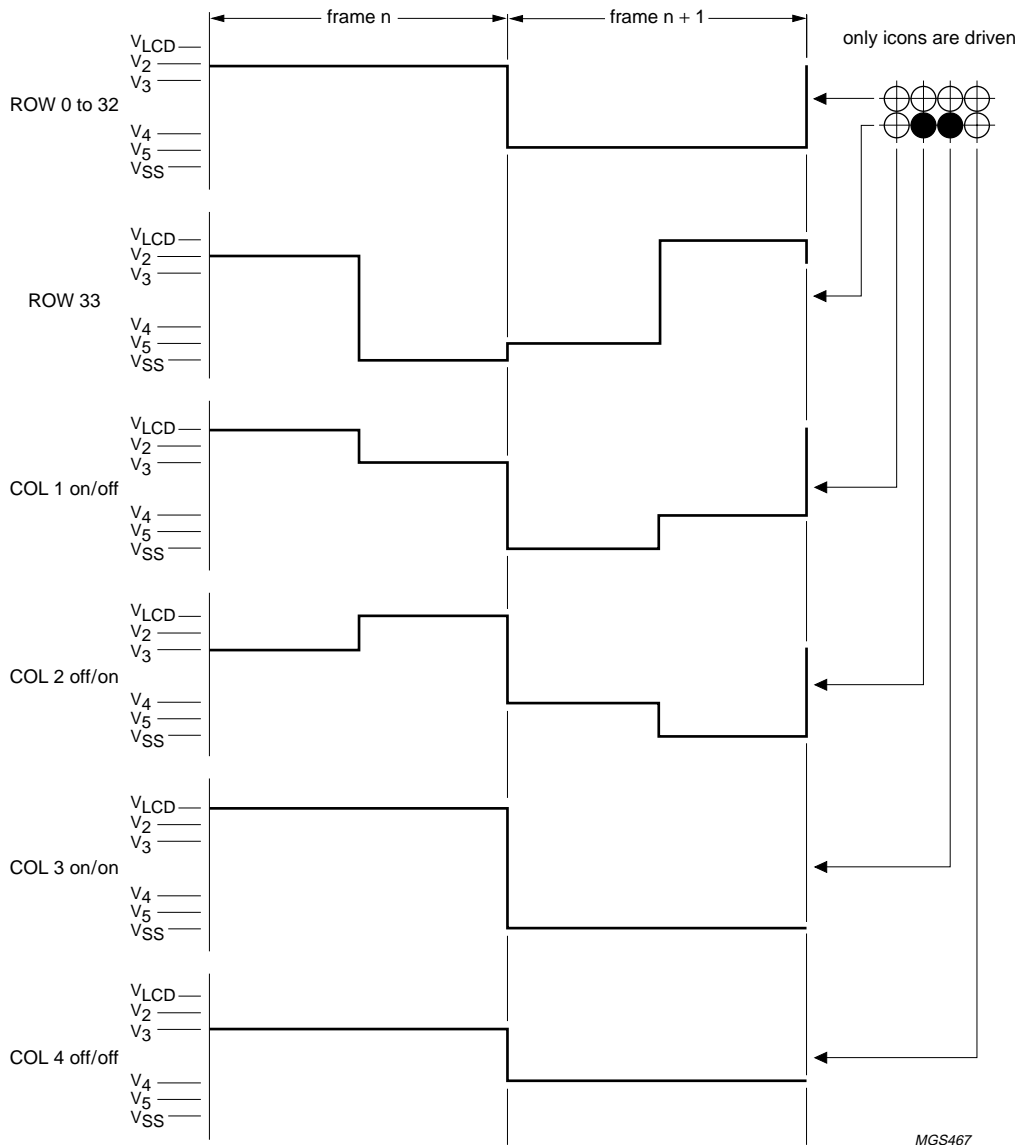


Fig.3 Icon mode; Mux 1 : 2 LCD waveforms.

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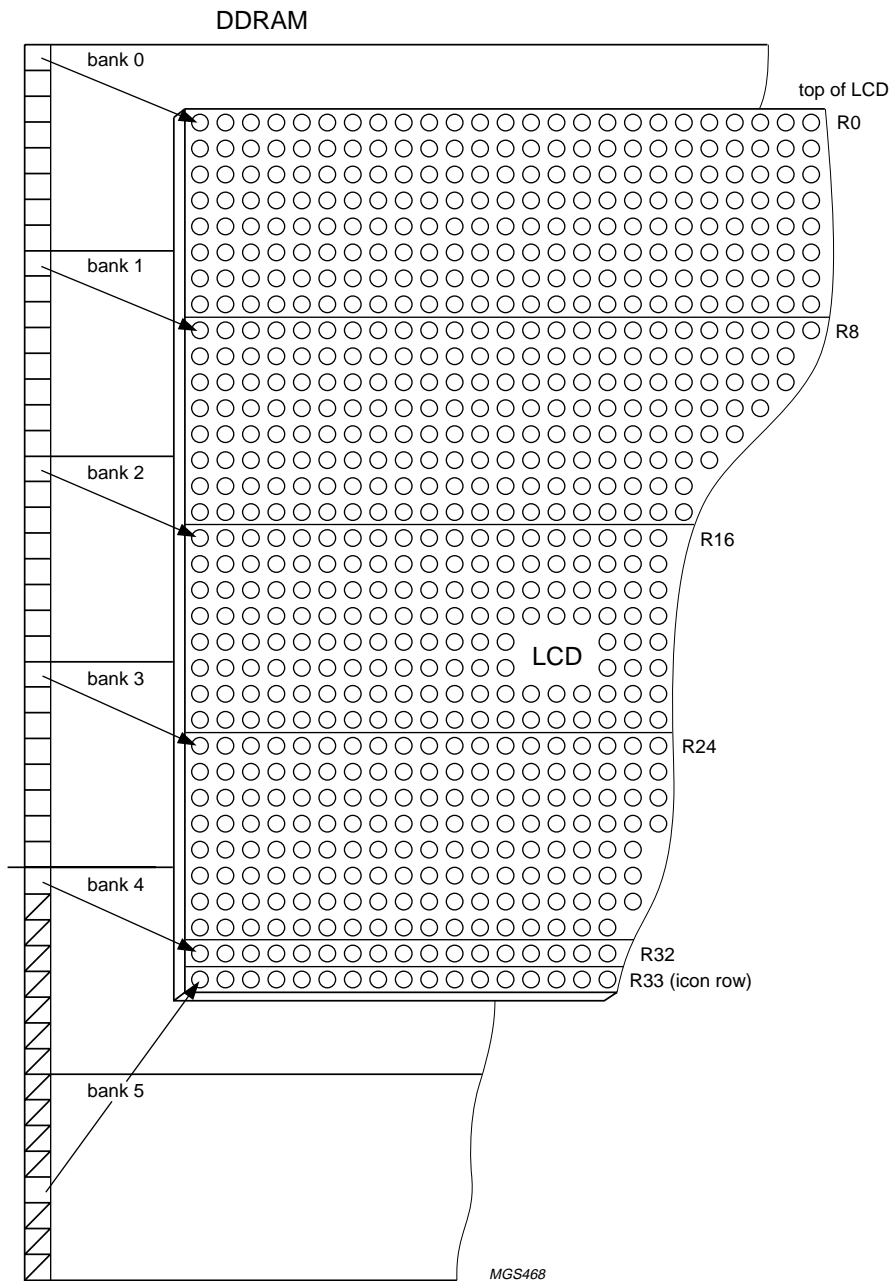


Fig.4 DDRAM to display mapping.

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8.17 Addressing

Data is written in bytes into the RAM matrix of the PCF8531 as illustrated in Figs 5, 6 and 7. The display RAM has a matrix of 34 × 128 bits. The columns are addressed by the address pointer. The address ranges are X 0 to X 127 (7FH) and Y 0 to Y 5 (5H). Addresses outside of these ranges are not allowed. In vertical addressing mode (V = 1), the Y address increments after each byte (see Fig.6). After the last Y address (Y = 4), Y wraps around to 0 and X increments to address the next

column. In horizontal addressing mode (V = 0), the X address increments after each byte (see Fig.7). After the last X address (X = 127), X wraps around to 0 and Y increments to address the next row. After the very last address (X = 127 and Y = 4), the address pointers wrap around to address (X = 0 and Y = 0). It should be noted that in bank 4 only the LSB (DB0) of the data will be written into the RAM. The Y address 5 is reserved for icon data and is not affected by the addressing mode; it should be noted that in bank 5 only the 5th data bit (DB4) will be written into the RAM.

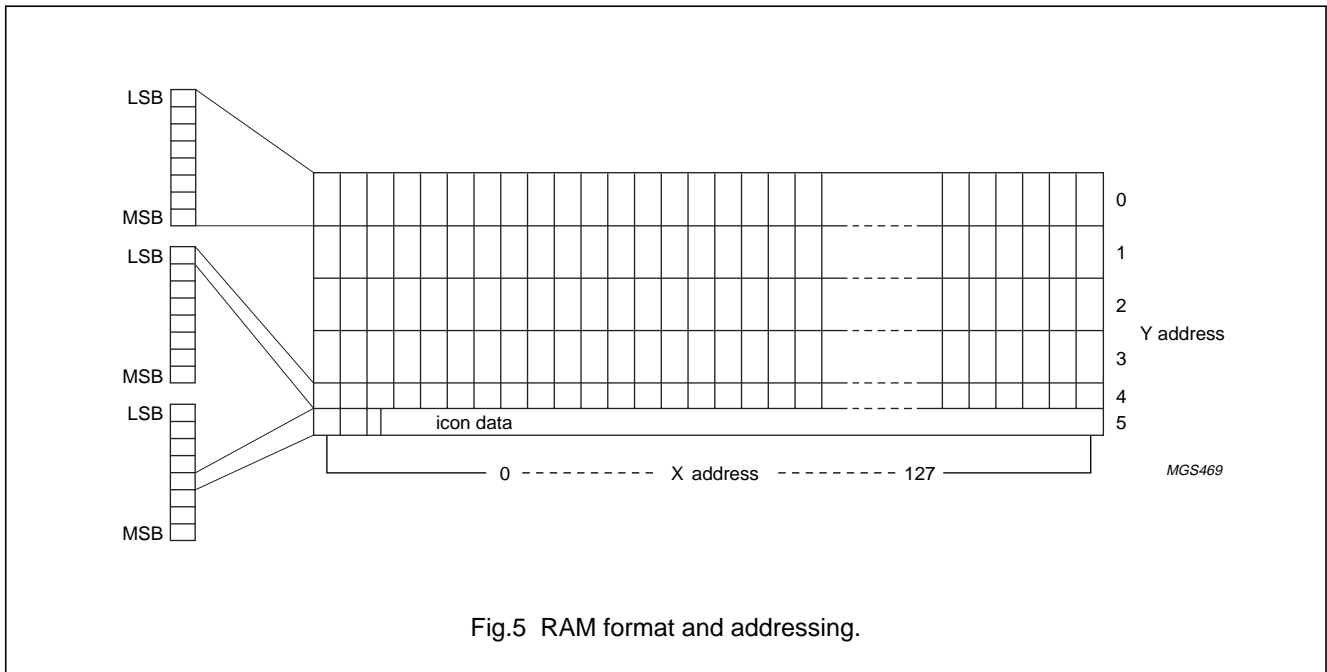


Fig.5 RAM format and addressing.

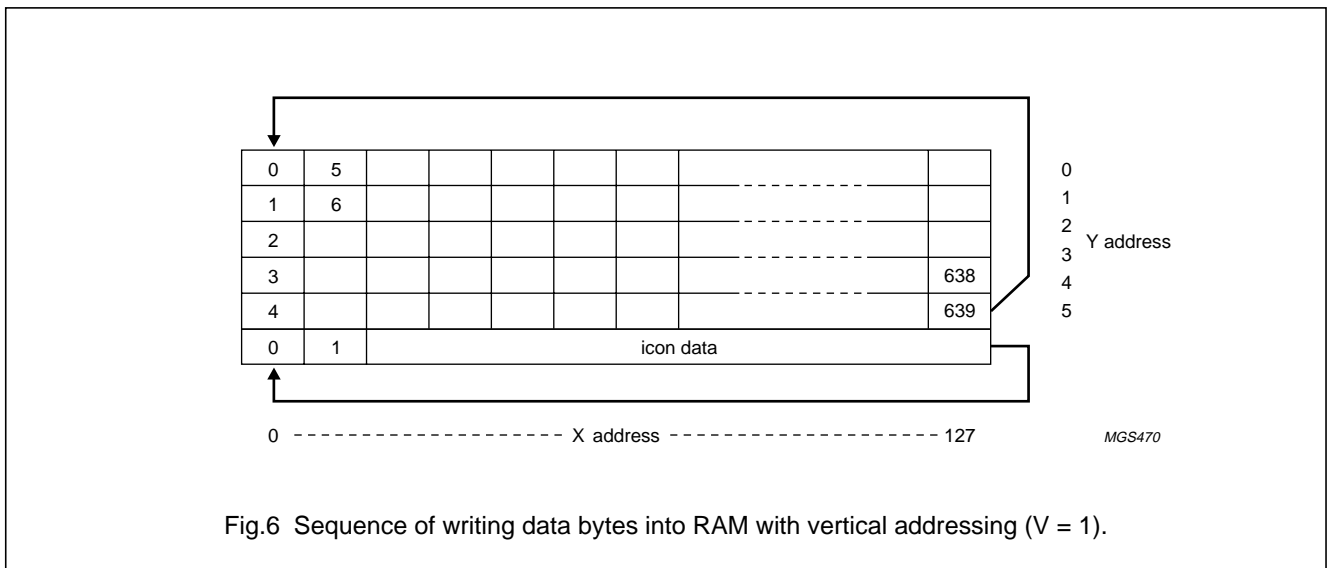


Fig.6 Sequence of writing data bytes into RAM with vertical addressing (V = 1).



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## 8.18.2 FUNCTION SET

### 8.18.2.1 PD

When PD = 1, the Power-down mode of the LCD driver is active:

- All LCD outputs at V<sub>SS</sub> (display off)
- Power-on reset detection active, oscillator off
- V<sub>LCD</sub> can be disconnected
- I<sup>2</sup>C-bus is operational, commands can be executed
- RAM contents not cleared; RAM data can be written
- Register settings remain unchanged.

### 8.18.2.2 V

When V = 0 the horizontal addressing is selected. The data is written into the DDRAM as shown in Fig.7. When V = 1 the vertical addressing is selected. The data is written into the DDRAM as shown in Fig.6. Icon data is written independently of V when Y address is 5.

## 8.18.3 SET Y ADDRESS

Bits Y<sub>2</sub>, Y<sub>1</sub> and Y<sub>0</sub> define the Y address vector of the display RAM.

**Table 1** Y address

Y <sub>2</sub>	Y <sub>1</sub>	Y <sub>0</sub>	BANK
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5 (icons)

**Table 2** Programming the required bias system

BS[2]	BS[1]	BS[0]	n	BIAS SYSTEM	COMMENT
0	0	0	7	1/11	
0	0	1	6	1/10	
0	1	0	5	1/9	
0	1	1	4	1/8	
1	0	0	3	1/7	recommended for 1 : 34
1	0	1	2	1/6	recommended for 1 : 26
1	1	0	1	1/5	recommended for 1 : 17
1	1	1	0	1/4	recommended for icon mode

## 8.18.4 SET X ADDRESS

The X address points to the columns. The range of X is 0 to 127 (7FH).

## 8.18.5 SET MULTIPLEX RATE

M[1:0] selects the multiplex rate (see Table 8).

## 8.18.6 DISPLAY CONTROL (D, E AND IM)

Bits D and E select the display mode (see Table 6). Bit IM sets the display to icon mode.

## 8.18.7 SET BIAS SYSTEM

Different multiplex rates require different bias settings. These are programmed by BS[2:0], which sets the binary number n. The optimum value for n is given by

$$n = \sqrt{\text{Mux rate}} - 3$$

Supported values of n are given in Table 2. Table 3 shows the intermediate bias voltages.

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8.18.8 LCD BIAS VOLTAGE

**Table 3** Intermediate LCD bias voltages

SYMBOL	BIAS VOLTAGES	EXAMPLE FOR 1/7 BIAS
V1	V <sub>LCD</sub>	V <sub>LCD</sub>
V2	$\frac{n+3}{n+4} \times V_{LCD}$	$\frac{6}{7} \times V_{LCD}$
V3	$\frac{n+2}{n+4} \times V_{LCD}$	$\frac{5}{7} \times V_{LCD}$
V4	$\frac{2}{n+4} \times V_{LCD}$	$\frac{2}{7} \times V_{LCD}$
V5	$\frac{1}{n+4} \times V_{LCD}$	$\frac{1}{7} \times V_{LCD}$
V6	V <sub>SS</sub>	V <sub>SS</sub>

8.18.9 SET V<sub>OP</sub> VALUE:

The operating voltage V<sub>LCD</sub> can be set by software. The voltage at reference temperature [V<sub>LCD</sub> (T = T<sub>cut</sub>)] can be calculated as: V<sub>LCD</sub> (T<sub>cut</sub>) = (a + V<sub>OP</sub> × b).

The generated voltage is dependent on the temperature, programmed Temperature Coefficient (TC) and the programmed voltage at reference temperature (T<sub>cut</sub>).  
 $V_{LCD} = V_{LCD} (T_{cut}) \times [1 + TC \times (T - T_{cut})]$ .

The parameter values are given in Table 4. Two overlapping V<sub>LCD</sub> ranges can be selected via the command 'HV-gen control' (see Table 4 and Fig.8). The maximum voltage that can be generated depends on the V<sub>DD2</sub> and V<sub>DD3</sub> voltages and the display load current. For Mux 1 : 34, the optimum operating voltage of the liquid can be calculated as:

$$V_{LCD} = \frac{1 + \sqrt{34}}{\sqrt{2 \times \left(1 - \frac{1}{\sqrt{34}}\right)}} \times V_{th} = 5.30 \times V_{th}$$

Where V<sub>th</sub> is the threshold voltage of the liquid crystal material used.

The practical value for V<sub>OP</sub> is determined by equating V<sub>off(rms)</sub> with a defined LCD threshold voltage (V<sub>th</sub>), typically when the LCD exhibits approximately 10% contrast.

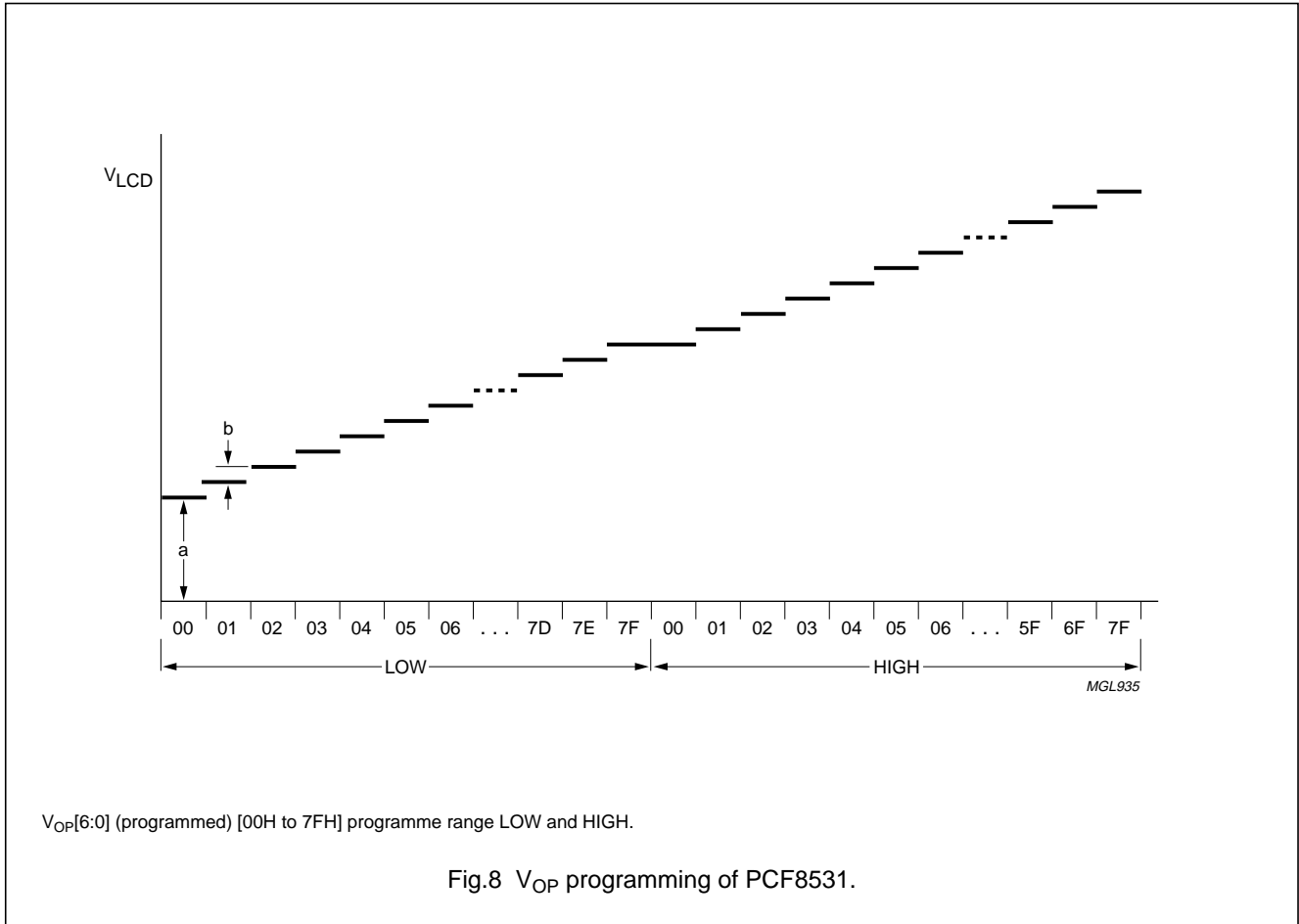
As the programming range for the internally generated V<sub>LCD</sub> allows values above the maximum allowed V<sub>LCD</sub>, the user has to ensure, while setting the V<sub>OP</sub> register and selecting the temperature compensation, that the V<sub>LCD</sub> limit of maximum 9 V will never be exceeded under all conditions and including all tolerances.

**Table 4** Parameter values for the HV generator programming

SYMBOL	VALUE		UNIT
	PRS = 0	PRS = 1	
T <sub>cut</sub>	27	27	°C
a	2.94	6.75	V
b	0.03	0.03	V
Programming range	2.94 to 6.75	6.75 to 10.56	V

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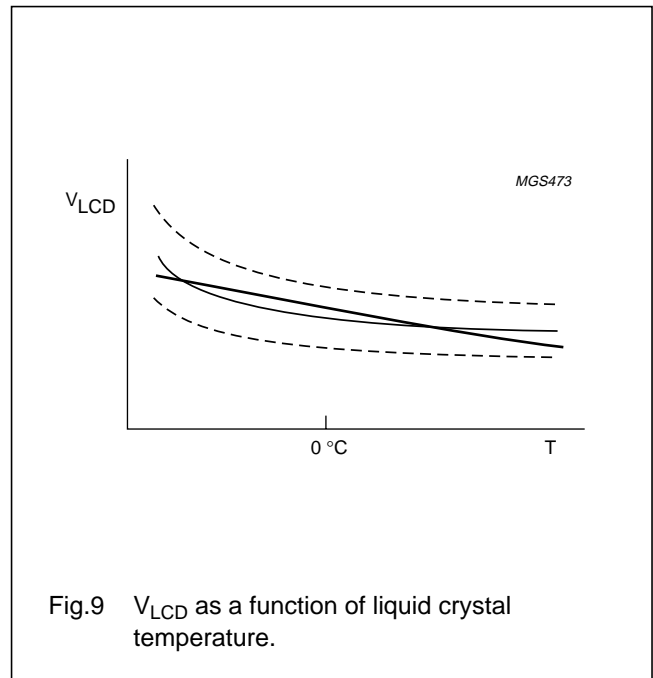
8.18.10 VOLTAGE MULTIPLIER CONTROL S[1:0]

The PCF8531 incorporates a software configurable voltage multiplier. After reset (internal or external), the voltage multiplier is set to  $2 \times V_{DD2}$ . The voltage multiplier factors are set via the command 'HV-gen configuration' (see Tables 4, 5 and 6).

8.18.11 TEMPERATURE COMPENSATION

Due to the temperature dependency of the liquid crystal's viscosity, the LCD controlling voltage  $V_{LCD}$  should usually be increased at lower temperatures to maintain optimum contrast. Figure 9 shows  $V_{LCD}$  for high multiplex rates.

Linear temperature compensation is supported in the PCF8531. The temperature coefficient of  $V_{LCD}$  can be selected from eight values by setting bits TC[2:0] (see Tables 4, 5 and 6).



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Table 5 Instruction set

INSTRUCTION	I <sup>2</sup> C-BUS COMMAND <sup>(1)</sup>		I <sup>2</sup> C-BUS COMMAND BYTE								DESCRIPTION
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
<b>H<sub>1</sub> and H<sub>0</sub> = don't care (H independent command page)</b>											
NOP	0	0	0	0	0	0	0	0	0	0	no operation
Write data	1	0	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	write data to display RAM
Set default H[1:0]	0	0	0	0	0	0	0	0	0	1	select H[1:0] = 0
<b>H<sub>1</sub> = 0 and H<sub>0</sub> = 0 (function and RAM command page)</b>											
Instruction set	0	0	0	0	0	0	1	0	H <sub>1</sub>	H <sub>0</sub>	select command page
Function set	0	0	0	0	1	0	0	PD	V	0	power-down control; entry mode
Set Y address of RAM	0	0	0	1	0	0	0	Y <sub>2</sub>	Y <sub>1</sub>	Y <sub>0</sub>	set Y address of RAM; 0 ≤ Y ≤ 5
Set X address of RAM	0	0	1	X <sub>6</sub>	X <sub>5</sub>	X <sub>4</sub>	X <sub>3</sub>	X <sub>2</sub>	X <sub>1</sub>	X <sub>0</sub>	set X address part of RAM; 0 ≤ X ≤ 127
<b>H<sub>1</sub> = 0 and H<sub>0</sub> = 1 (display setting command page)</b>											
Multiplex rate	0	0	0	0	0	0	0	1	M <sub>1</sub>	M <sub>0</sub>	select multiplex rate
Display control	0	0	0	0	0	0	1	D	IM	E	set display configuration
Bias system	0	0	0	0	0	1	0	BS <sub>2</sub>	BS <sub>1</sub>	BS <sub>0</sub>	set Bias System (BSx)
<b>H<sub>1</sub> = 1 and H<sub>0</sub> = 0 (HV-gen command page)</b>											
HV-gen control	0	0	0	0	0	0	0	1	PRS	HVE	set V <sub>LCD</sub> programming range
HV-gen configuration	0	0	0	0	0	0	1	0	S <sub>1</sub>	S <sub>0</sub>	set voltage multiplication factor
Temperature control	0	0	0	0	1	0	0	TC <sub>2</sub>	TC <sub>1</sub>	TC <sub>0</sub>	set temperature coefficient
Test modes	0	0	0	1	X	X	X	X	X	X	do not use (reserved for test)
V <sub>LCD</sub> control	0	0	1	V <sub>OP6</sub>	V <sub>OP5</sub>	V <sub>OP4</sub>	V <sub>OP3</sub>	V <sub>OP2</sub>	V <sub>OP1</sub>	V <sub>OP0</sub>	set V <sub>LCD</sub> register 0 ≤ V <sub>OP</sub> ≤ 127

**Note**

1. R/W is set in the slave address byte; Co and RS are set in the control byte.



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**Table 6** Explanations for symbols in Table 5

BIT	0	1
PD	chip is active	chip is in Power-down mode
V	horizontal addressing	vertical addressing
IM	normal mode; full display + icons	icon mode; only icons are displayed
H[1:0] <sup>(1)</sup>	see Table 7	
D and E	see Table 7	
HVE	voltage multiplier disabled	voltage multiplier enabled
PRS	V <sub>LCD</sub> programming range LOW	V <sub>LCD</sub> programming range HIGH
TC[2:0]	see Table 7	
S[1:0]	see Table 7	

**Note**

1. The H-bits identify the command page (use set default H[1:0] command to set H[1:0] = 0).

**Table 7** Description of bits H, D and E, TC and S

BITS	VALUE	DESCRIPTION
<b>Command page (H)</b>		
H[1:0]	00	function and RAM command page
	01	display setting command page
	10	HV-gen command page
<b>Display modes (D, E)</b>		
D and E	00	display blank
	10	normal mode
	01	all display segments
	11	inverse video mode
<b>Temperature coefficient (TC)</b>		
TC[2:0]	000	temperature coefficient 0
	001	temperature coefficient 1
	010	temperature coefficient 2
	011	temperature coefficient 3
	100	temperature coefficient 4
	101	temperature coefficient 5
	110	temperature coefficient 6
	111	temperature coefficient 7
<b>Voltage multiplier factor (S)</b>		
S[1:0]	00	2 × voltage multiplier
	01	3 × voltage multiplier
	10	4 × voltage multiplier
	11	5 × voltage multiplier

**Table 8** Multiplex rates

MUX RATE	M1	M0
1 : 17	0	0
1 : 26	1	0
1 : 34	0	1

# 34 × 128 pixel matrix driver

# PCF8531

## 9 I<sup>2</sup>C-BUS INTERFACE

### 9.1 Characteristics of the I<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for bi-directional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial Clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

- Slave: the device addressed by a master
- Multi-Master: more than one master can attempt to control the bus at the same time without corrupting the message
- Arbitration: procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted
- Synchronization: procedure to synchronize the clock signals of two or more devices.

#### 9.1.1 BIT TRANSFER

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see Fig.10).

#### 9.1.4 ACKNOWLEDGE

Acknowledge on the I<sup>2</sup>C-bus is illustrated in Fig.13. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH signal put on the bus by the transmitter, during which time the master generates an extra acknowledge related clock pulse. A slave receiver that is addressed must generate an acknowledge after the reception of each byte.

#### 9.1.2 START AND STOP CONDITIONS

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in Fig.11.

Also, a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse so that the SDA line is stable LOW during the HIGH period of the acknowledge- related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an "end of data" to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

#### 9.1.3 SYSTEM CONFIGURATION

The system configuration is illustrated in Fig.12

- Transmitter: the device that sends the data to the bus
- Receiver: the device that receives the data from the bus
- Master: the device that initiates a transfer, generates clock signals and terminates a transfer

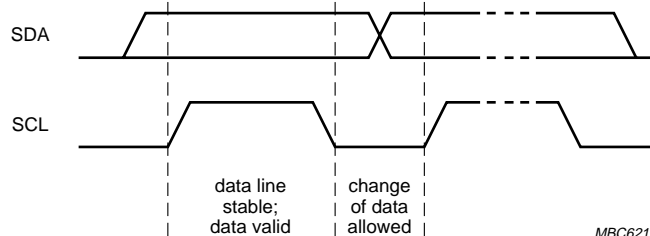
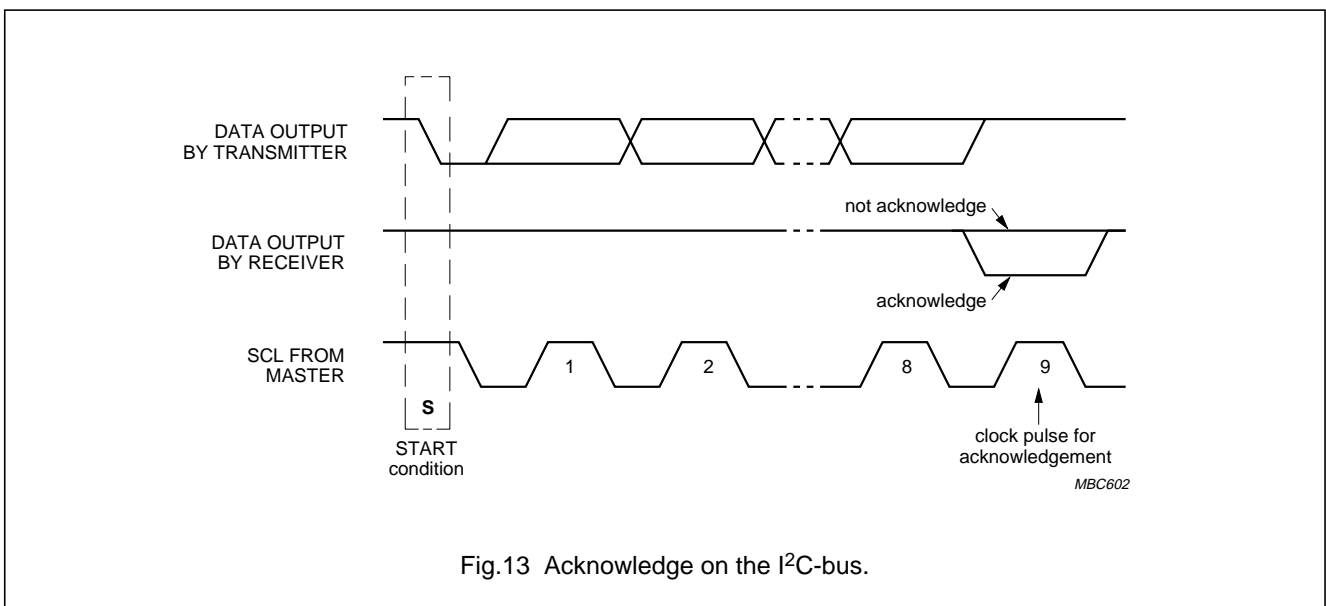
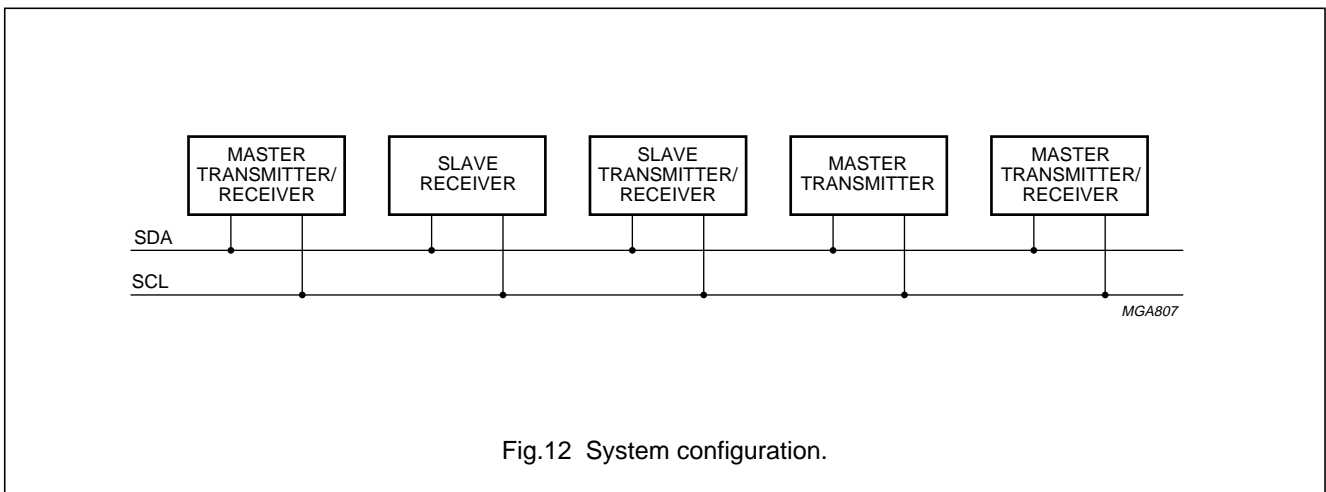
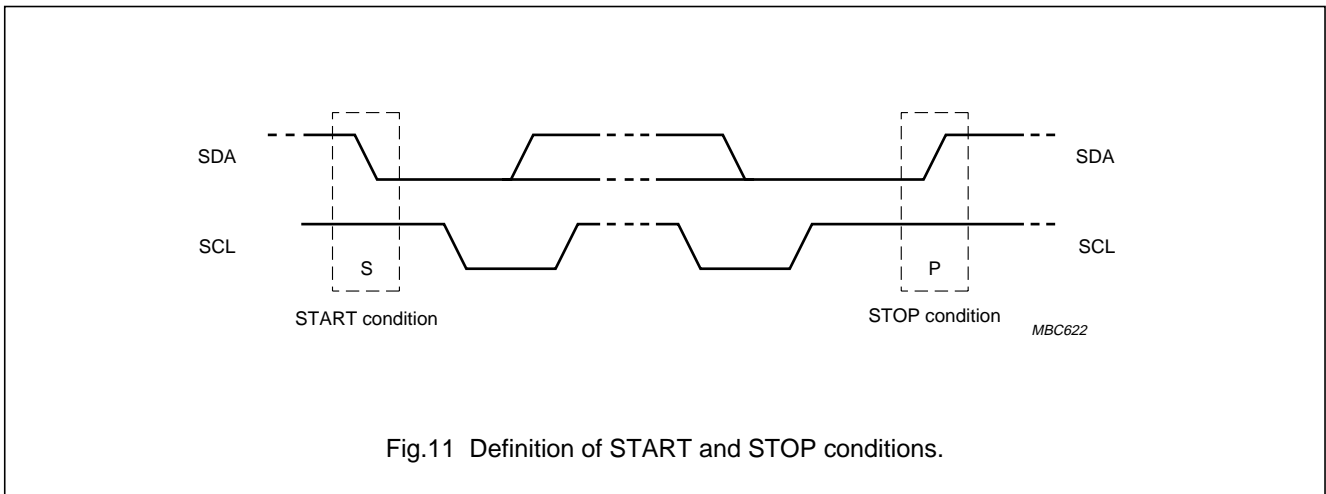


Fig.10 Bit transfer.

34 × 128 pixel matrix driver

PCF8531



34 × 128 pixel matrix driver

PCF8531

9.2 I<sup>2</sup>C-bus protocol

This driver does not support 'read'. The PCF8531 is a slave receiver. Therefore, it only responds when  $R/\overline{W} = 0$  in the slave address byte.

Before any data is transmitted on the I<sup>2</sup>C-bus, the device that should respond is addressed first. Two 7-bit slave addresses (0111100 and 0111101) are reserved for the PCF8531. The least significant bit of the slave address is set by connecting the input SA0 to either logic 0 (V<sub>SS</sub>) or logic 1 (V<sub>DD</sub>).

The I<sup>2</sup>C-bus protocol is illustrated in Fig.14.

The sequence is initiated with a START condition (S) from the I<sup>2</sup>C-bus master, and is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all others ignore the I<sup>2</sup>C-bus transfer. After acknowledgement, one or more command words follow, which define the status of the addressed slaves. A command word consists of a control byte, which defines Co and RS, plus a data byte (see Fig.14 and Table 1).

The last control byte is tagged with a cleared most significant bit, the continuation bit Co. The control and data bytes are also acknowledged by all addressed slaves on the bus.

After the last control byte, depending on the RS bit setting, either a series of display data bytes or command data bytes may follow. If the RS bit was set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer.

The data pointer is automatically updated and the data is directed to the intended PCF8531 device. If the RS bit of the last control byte was set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands.

The acknowledgement after each byte is made only by the addressed PCF8531. At the end of the transmission, the I<sup>2</sup>C-bus master issues a STOP condition (P).

9.3 Command decoder

- Pairs of bytes; information in the second byte, the first byte determines whether information is display or instruction data
- Stream of information bytes after Co = 0; display or instruction data, depending on last RS (Register Selection).

The command decoder identifies command words that arrive on the I<sup>2</sup>C-bus. The most significant bit of a control byte is the continuation bit Co. If this bit is logic 1, it indicates that only one data byte (either command or RAM data) will follow. If this bit is logic 0, it indicates that a series of data bytes (either command or RAM data) may follow. The DB6 bit of a control byte is the RAM data/command bit RS. When this bit is at logic 1, it indicates that another RAM data byte will be transferred next. If the bit is at logic 0, it indicates that another command byte will be transferred next.

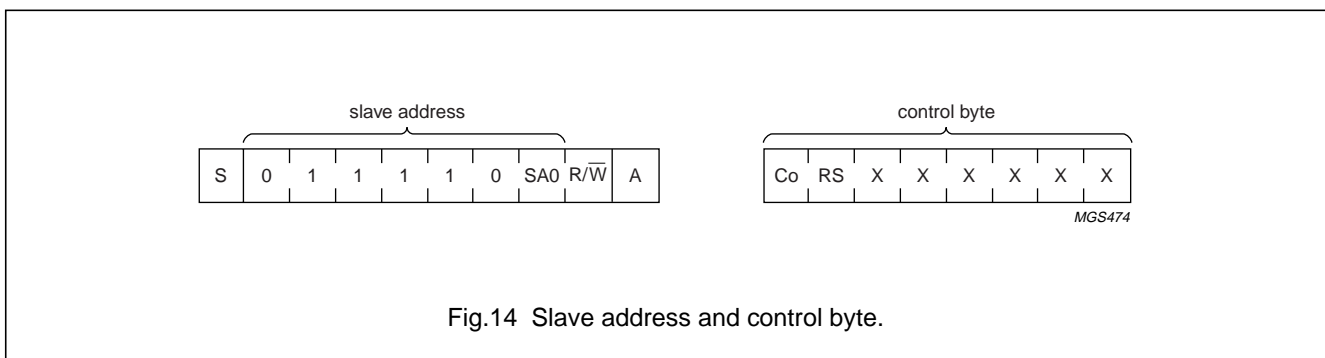


Fig.14 Slave address and control byte.

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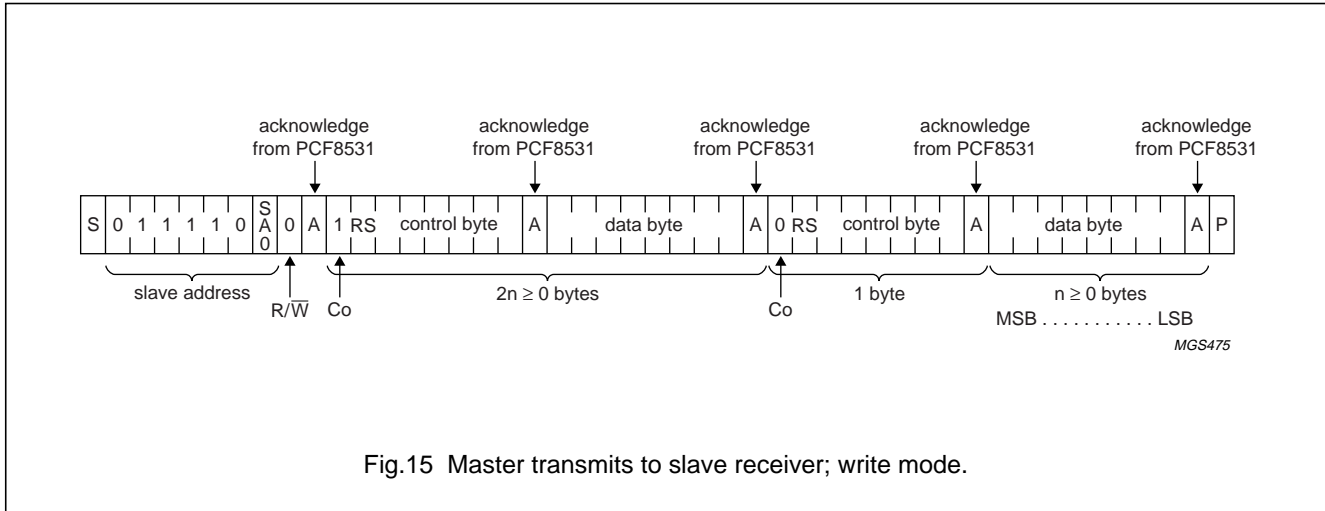


Fig.15 Master transmits to slave receiver; write mode.

10 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134); note 1.

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V <sub>DD1</sub>	logic supply voltage	-0.5	+5.5	V
V <sub>DD2</sub> , V <sub>DD3</sub>	multiplier supply voltage	-0.5	+4.5	V
I <sub>DD</sub>	supply current	-50	+50	mA
V <sub>LCD</sub>	LCD supply voltage	-0.5	+9.0	V
I <sub>LCD</sub>	LCD supply current	-50	+50	mA
I <sub>SS</sub>	negative supply current	-50	+50	mA
V <sub>I</sub> /V <sub>O</sub>	input/output voltage (any input/output)	-0.5	V <sub>DD</sub> + 0.5	V
I <sub>I</sub>	DC input current	-10	+10	mA
I <sub>O</sub>	DC output current	-10	+10	mA
P <sub>tot</sub>	total power dissipation per package	-	300	mW
P/out	power dissipation per output	-	30	mW
T <sub>stg</sub>	storage temperature	-65	+150	°C
T <sub>j</sub>	junction temperature	-	150	°C

Note

- Parameters are valid over the operating temperature range unless otherwise specified. All voltages referenced to V<sub>SS</sub> unless otherwise noted.

11 HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is recommended to take normal precautions appropriate to handling MOS devices (see "Handling MOS Devices").

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**12 DC CHARACTERISTICS**

$V_{DD1} = 1.8$  (1.9) to 5.5 V;  $V_{DD2}$  and  $V_{DD3} = 2.5$  to 4.5 V;  $V_{SS1,2} = 0$  V;  $V_{DD1}$  to  $V_{DD3} \leq V_{LCD} \leq 9.0$  V;  
 $T_{amb} = -40$  to  $+85$  °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Supplies</b>						
$V_{LCD}$	LCD supply voltage	note 1	4.0	–	9.0	V
		icon mode; note 1	3.0	–	9.0	V
$V_{DD1}$	logic supply voltage		1.9	–	5.5	V
		$T_{amb} \geq -25$ °C	1.8	–	5.5	V
$V_{DD2}, V_{DD3}$	multiplier supply voltage	LCD voltage internally generated	2.5	–	4.5	V
$I_{DD}$	supply current	Power-down mode; internal $V_{LCD}$	–	2	10	$\mu$ A
		normal mode; internal $V_{LCD}$ ; notes 2 and 3	–	170	350	$\mu$ A
		normal mode; external $V_{LCD}$ ; note 2	–	10	50	$\mu$ A
$I_{LCD}$	LCD input current	normal mode; external $V_{LCD}$ ; notes 2 and 4	–	25	100	$\mu$ A
		icon mode; external $V_{LCD}$ ; notes 2 and 5	–	15	70	$\mu$ A
$V_{POR}$	Power-on reset level	note 6	0.9	1.2	1.6	V
<b>Logic</b>						
$V_{IL}$	LOW-level input voltage		$V_{SS}$	–	$0.3V_{DD}$	V
$V_{IH}$	HIGH-level input voltage		$0.7V_{DD}$	–	$V_{DD}$	V
$I_{OL}$	LOW-level output current (SDA)	$V_{OL} = 0.4$ V; $V_{DD} = 5$ V	3.0	–	–	mA
$I_{LI}$	input leakage current	$V_I = V_{DD}$ or $V_{SS}$	–1	–	+1	$\mu$ A
<b>Column and row outputs</b>						
$R_{O(col)}$	column output resistance C0 to C127	note 7	–	12	20	k $\Omega$
$R_{O(row)}$	row output resistance R0 to R33	note 7	–	12	20	k $\Omega$
$V_{bias(col)}$	bias tolerance C0 to C127		–100	0	+100	mV
$V_{bias(row)}$	bias tolerance R0 to R33		–100	0	+100	mV

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>V<sub>LCD</sub> generation</b>						
V <sub>LCD(tol)</sub>	LCD voltage tolerance, internal V <sub>LCD</sub>	TC1 to TC7; note 8	–	–	±3.9	%
TC0	LCD voltage temperature coefficient 0	T <sub>amb</sub> = –20 to +70 °C	–	0	–	%/°C
TC1	LCD voltage temperature coefficient 1	T <sub>amb</sub> = –20 to +70 °C	–	–0.026	–	%/°C
TC2	LCD voltage temperature coefficient 2	T <sub>amb</sub> = –20 to +70 °C	–	–0.039	–	%/°C
TC3	LCD voltage temperature coefficient 3	T <sub>amb</sub> = –20 to +70 °C	–	–0.052	–	%/°C
TC4	LCD voltage temperature coefficient 4	T <sub>amb</sub> = –20 to +70 °C	–	–0.078	–	%/°C
TC5	LCD voltage temperature coefficient 5	T <sub>amb</sub> = –20 to +70 °C	–	–0.13	–	%/°C
TC6	LCD voltage temperature coefficient 6	T <sub>amb</sub> = –20 to +70 °C	–	–0.19	–	%/°C
TC7	LCD voltage temperature coefficient 7	T <sub>amb</sub> = –20 to +70 °C	–	–0.26	–	%/°C
T <sub>cut</sub>	cut point temperature		–	27	–	°C

**Notes**

- As the programming range for the internally generated V<sub>LCD</sub> allows values above the maximum allowed V<sub>LCD</sub>, the user has to ensure, while setting the V<sub>OP</sub> register and selecting the temperature compensation, that the V<sub>LCD</sub> limit of maximum 9 V will never be exceeded under all conditions and including all tolerances.
- LCD outputs are open circuit, inputs at V<sub>DD</sub> or V<sub>SS</sub>; bus inactive.
- V<sub>DD1</sub> to V<sub>DD3</sub> = 2.85 V; V<sub>LCD</sub> = 7.0 V; voltage multiplier = 3 × V<sub>DD</sub>; f<sub>OSC</sub> = 34 kHz.
- V<sub>DD1</sub> to V<sub>DD3</sub> = 2.75 V; V<sub>LCD</sub> = 9.0 V; f<sub>OSC</sub> = 34 kHz.
- V<sub>DD1</sub> to V<sub>DD3</sub> = 2.75 V; V<sub>LCD</sub> = 3.5 V; f<sub>OSC</sub> = 34 kHz.
- Resets all logic when V<sub>DD1</sub> < V<sub>POR</sub>.
- |I<sub>LOAD</sub>| ≤ 50 μA; outputs tested one at a time.
- V<sub>LCD</sub> ≤ 7.7 V.

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**13 AC CHARACTERISTICS**

$V_{DD1} = 1.8$  to  $5.5$  V;  $V_{DD2}$  and  $V_{DD3} = 2.5$  to  $4.5$  V;  $V_{SS1}$  and  $V_{SS2} = 0$  V;  $V_{DD1}$  to  $V_{DD3} \leq V_{LCD} \leq 9.0$  V;  
 $T_{amb} = -40$  to  $+85$  °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$f_{frame}$	LCD frame frequency (internal clock)	$V_{DD} = 3.0$ V; note 1	40	66	135	Hz
$f_{OSC}$	oscillator frequency (not available at any pin)		20	34	65	kHz
$f_{clk(ext)}$	external clock frequency		20	–	65	kHz
$t_{W(RESL)}$	reset LOW pulse width	note 2	300	–	–	ns
$t_{SU;RESL}$	reset LOW pulse set-up time after Power-on		–	–	30	$\mu$ s
<b>Serial-bus interface; note 3</b>						
$f_{SCL}$	SCL clock frequency		0	–	400	kHz
$t_{SCLL}$	SCL clock LOW period		1.3	–	–	$\mu$ s
$t_{SCLH}$	SCL clock HIGH period		0.6	–	–	$\mu$ s
$t_{SU;DAT}$	data set-up time		100	–	–	ns
$t_{HD;DAT}$	data hold time		0	–	0.9	$\mu$ s
$t_r$	SCL, SDA rise time	note 4	$20 + 0.1C_b$	–	300	ns
$t_f$	SCL, SDA fall time	note 4	$20 + 0.1C_b$	–	300	ns
$C_b$	capacitive load represented by each bus line		–	–	400	pF
$t_{SU;STA}$	set-up time for a repeated START condition		0.6	–	–	$\mu$ s
$t_{HD;STA}$	start condition hold time		0.6	–	–	$\mu$ s
$t_{SU;STO}$	set-up time for STOP condition		0.6	–	–	$\mu$ s
$t_{SW}$	tolerable spike width on bus		–	–	50	ns
$t_{BUF}$	bus free time between a STOP and START condition		1.3	–	–	$\mu$ s

**Notes**

- $f_{frame} = f_{clk(ext)}/480$ ;  $f_{OSC}/480$ .
- For  $t_{W(RESL)} > 3$  ns a reset may be generated.
- All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .
- $C_b$  = total capacitance of one bus line in pF.

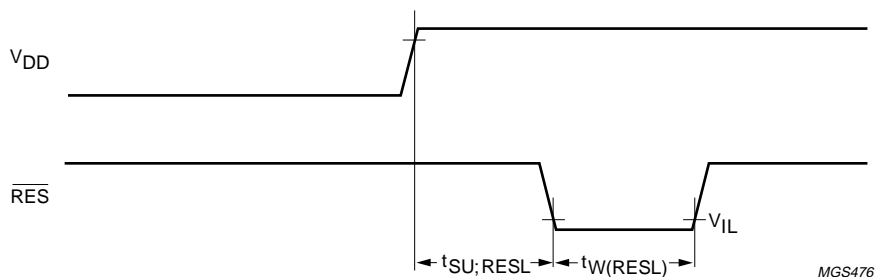


Fig.16 Reset timing.



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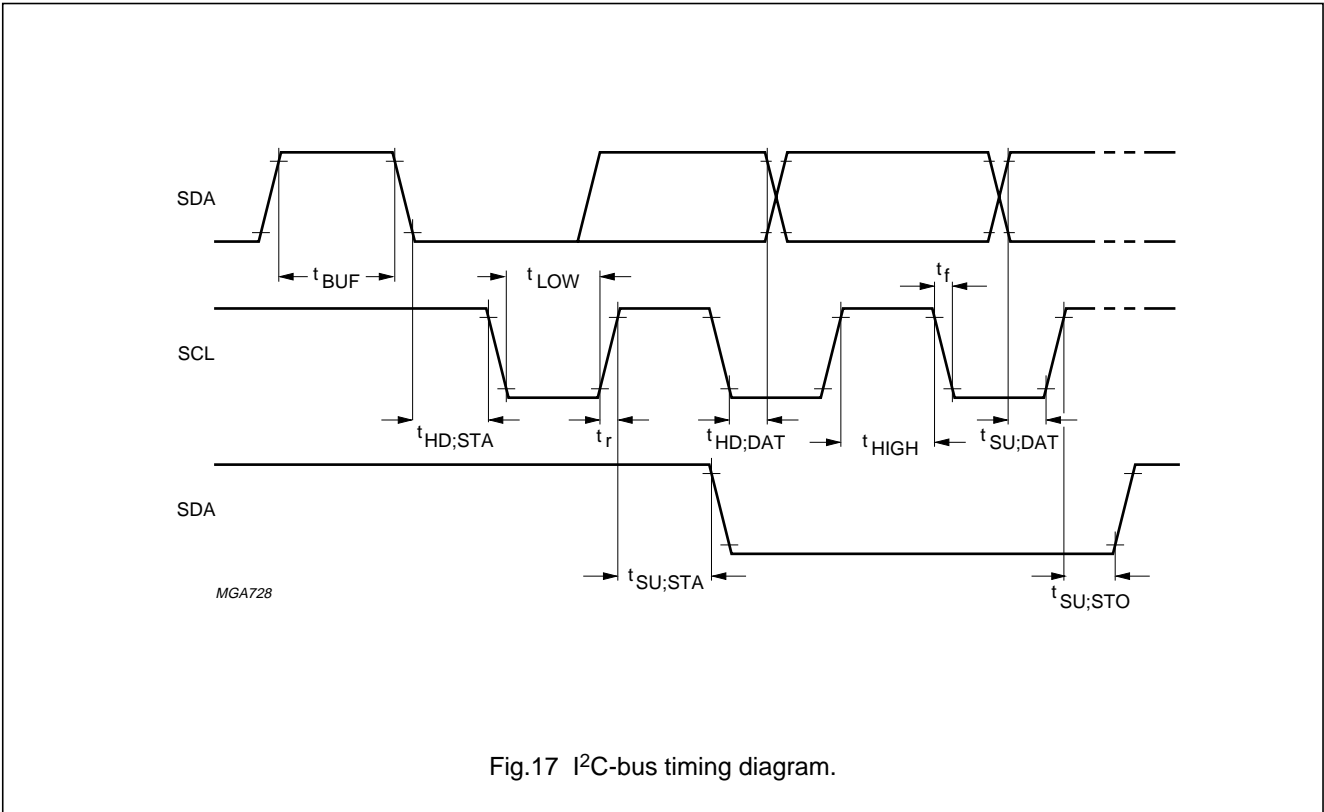


Fig.17 I<sup>2</sup>C-bus timing diagram.

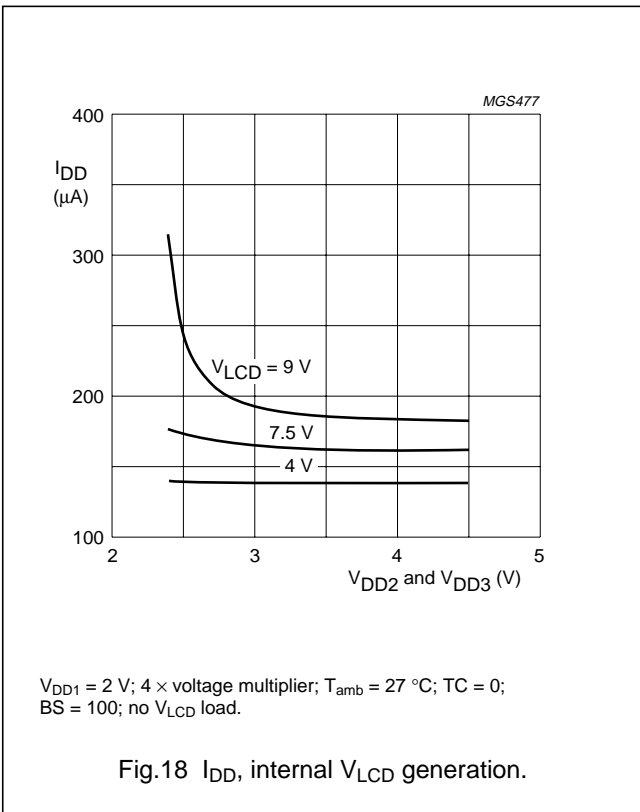


Fig.18  $I_{DD}$ , internal  $V_{LCD}$  generation.

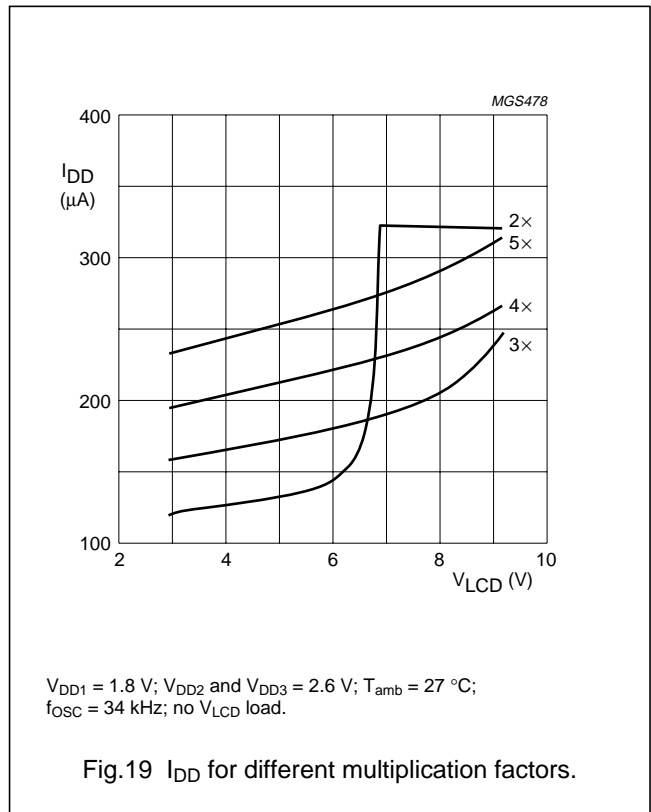
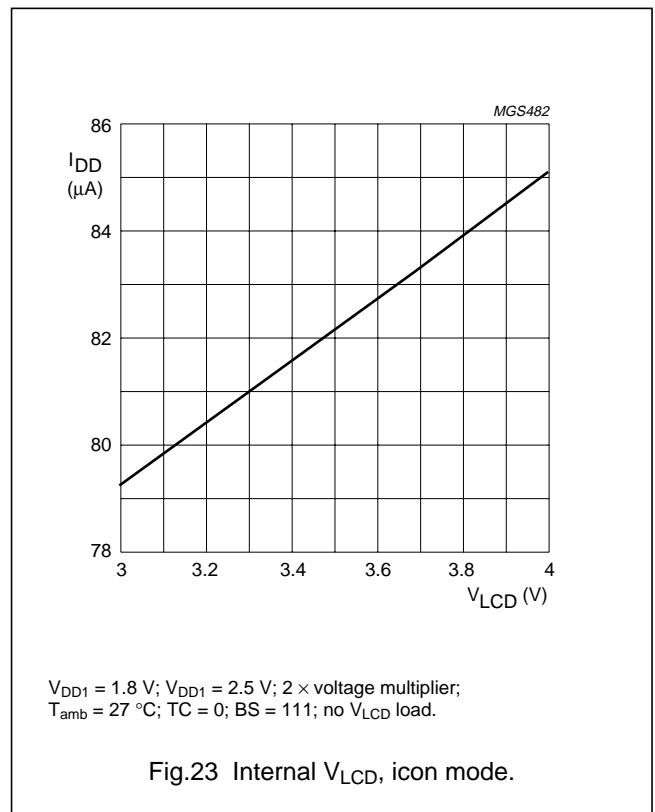
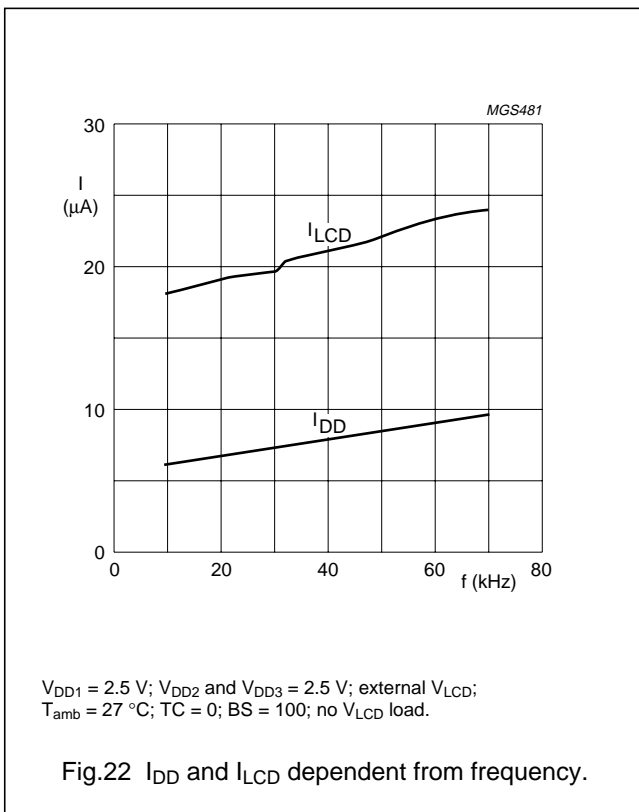
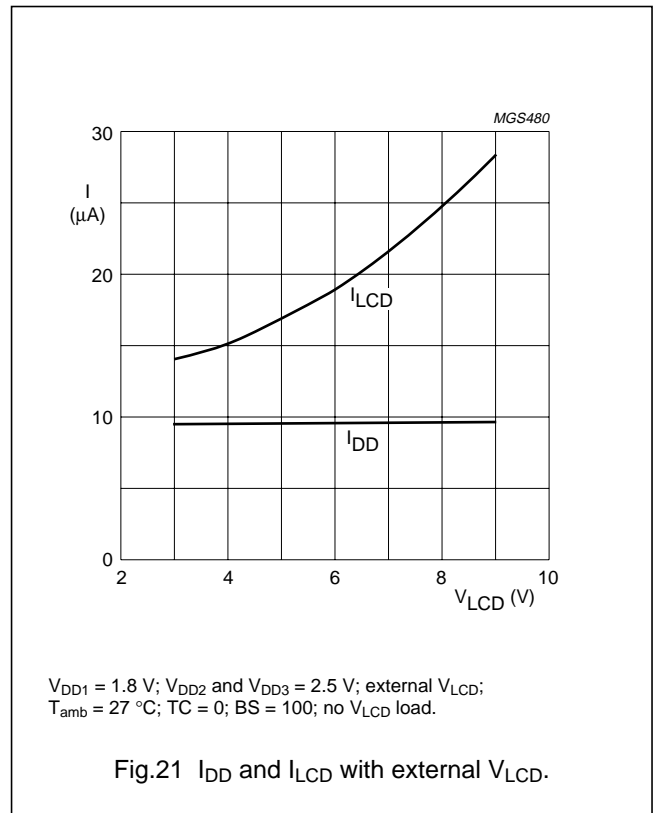
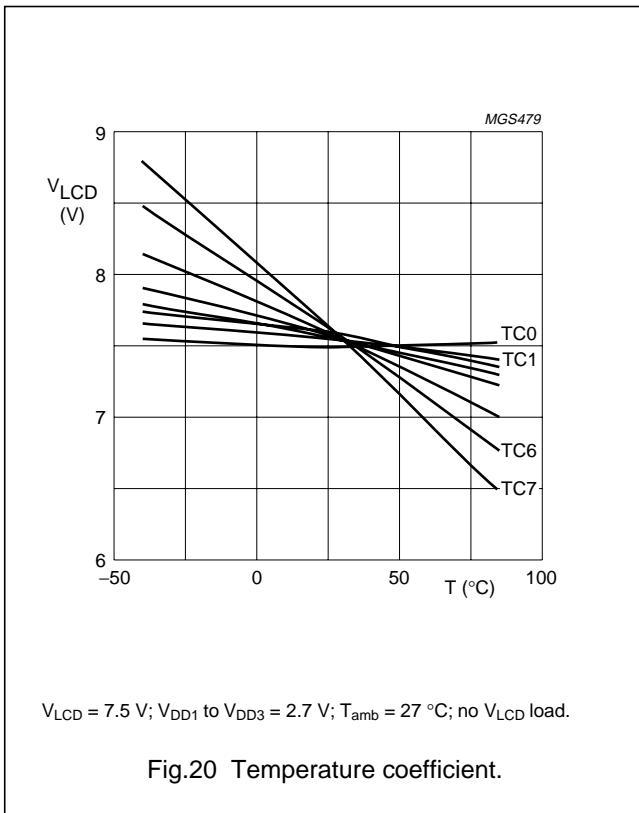


Fig.19  $I_{DD}$  for different multiplication factors.

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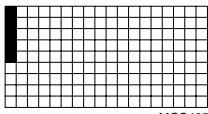
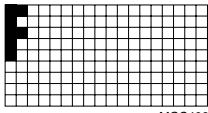
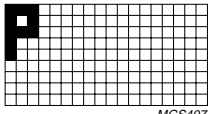
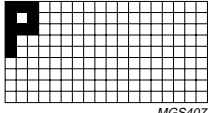
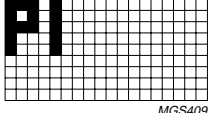
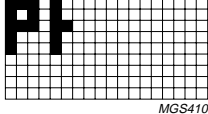
## 14 APPLICATION INFORMATION

Table 9 Programming example for PCF8531

STEP	SERIAL BUS BYTE								DISPLAY	OPERATION
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
1	0	1	1	1	1	0	SA0	0		start; slave address; R/W = 0
2	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
3	0	0	0	0	0	0	0	1		H[1:0] independent command; select function and RAM command page (H[1:0] = 00)
4	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
5	0	0	1	0	0	0	1	0		function and RAM command page PD = 0 and V = 1
6	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
7	0	0	0	0	1	0	0	1		function and RAM command page select display setting command page H[1:0] = 01
8	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
9	0	0	0	0	1	1	0	0		display setting command page; set normal mode (D = 1; IM = 0 and E = 0)
10	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
11	0	0	0	0	0	1	0	1		select Mux rate 1 : 34
12	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
13	0	0	0	0	0	0	0	1		H[2:0] independent command; select function and RAM command page H[1:0] = 00
14	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
15	0	0	0	0	1	0	1	0		function and RAM command page; select HV-gen command page H[1:0] = 10
16	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
17	0	0	0	0	1	0	1	1		HV-gen command page; select voltage multiplication factor 5 S[1:0] = 11
18	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
19	0	0	1	0	0	0	1	0		HV-gen command page; select temperature coefficient 2 TC[2:0] = 010
20	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0

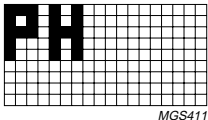
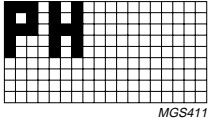
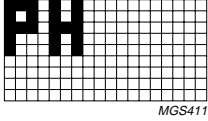
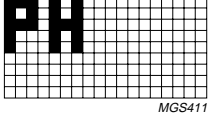
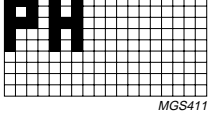
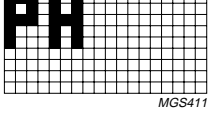
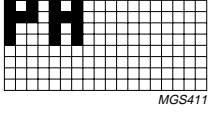
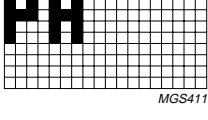
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STEP	SERIAL BUS BYTE								DISPLAY	OPERATION
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
21	0	0	0	0	0	1	1	1		HV-gen command page; select high V <sub>LCD</sub> programming range (PRS = 1); voltage multiplier off (HVE = 1)
22	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
23	1	0	1	0	0	0	0	0		HV-gen command page; set V <sub>LCD</sub> = 7.71 V; V <sub>OP</sub> [6:0] = 0100000
24	0	1	0	0	0	0	0	0		control byte; Co = 0; RS = 1
25	0	0	0	1	1	1	1	1	 <small>MGS405</small>	data write; Y and X are initialized to 0 by default, so they are not set here
26	0	0	0	0	0	1	0	1	 <small>MGS406</small>	data write
27	0	0	0	0	0	1	1	1	 <small>MGS407</small>	data write
28	0	0	0	0	0	0	0	0	 <small>MGS407</small>	data write
29	0	0	0	1	1	1	1	1	 <small>MGS409</small>	data write
30	0	0	0	0	0	1	0	0	 <small>MGS410</small>	data write

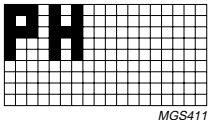
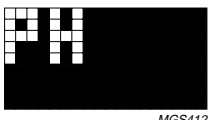
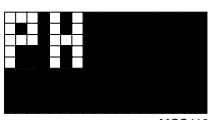
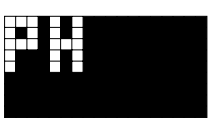
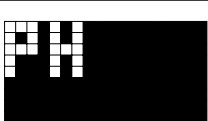
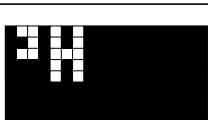
34 × 128 pixel matrix driver

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STEP	SERIAL BUS BYTE								DISPLAY	OPERATION
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
31	0	0	0	1	1	1	1	1		data write; last data and stop transmission
32	0	1	1	1	1	0	SA0	0		repeated start; slave address; $R/\bar{W} = 0$
33	1	0	0	0	0	0	0	0		control byte; $Co = 1$ ; $RS = 0$
34	0	0	0	0	0	0	0	1		H[1:0] independent command; select function and RAM command page H[1:0] = 00
35	1	0	0	0	0	0	0	0		control byte; $Co = 1$ ; $RS = 0$
36	0	0	0	0	1	0	0	1		function and RAM command page; select display setting command page H[1:0] = 01
37	1	0	0	0	0	0	0	0		control byte; $Co = 1$ ; $RS = 0$
38	0	0	0	0	0	0	0	1		H[1:0] independent command; select function and RAM command page H[1:0] = 00

34 × 128 pixel matrix driver

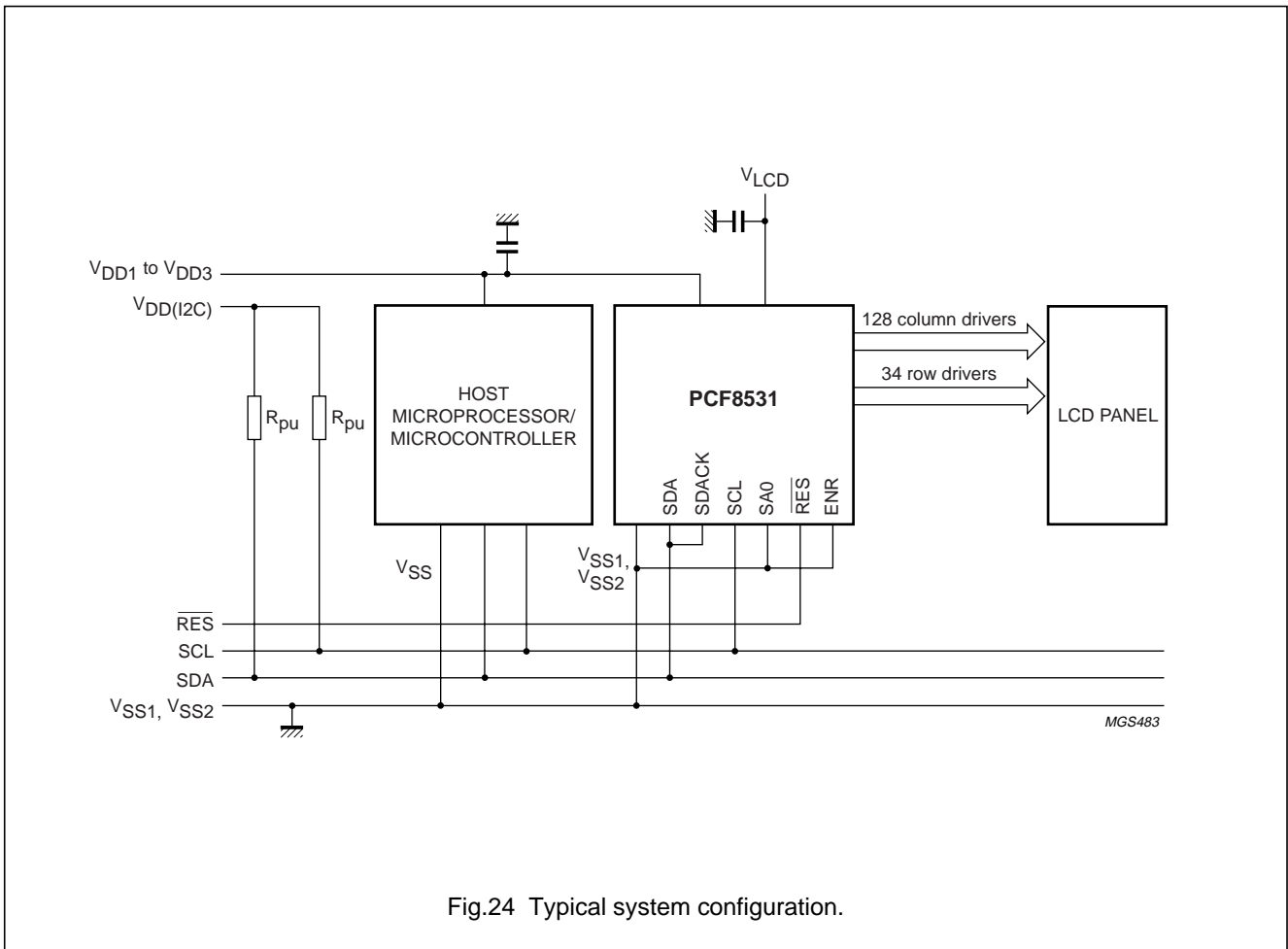
PCF8531

STEP	SERIAL BUS BYTE								DISPLAY	OPERATION
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
39	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
40	0	0	0	0	1	1	0	1		display control; set inverse video mode (D = 1; E = 1 and IM = 0)
41	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
42	1	0	0	0	0	0	0	0		set X address of RAM; set address to '0000000'
43	0	1	0	0	0	0	0	0		control byte; Co = 0; RS = 1
44	0	0	0	0	0	0	0	0		data write

The pinning of the PCF8531 is optimized for single plane wiring e.g. for chip-on-glass display modules. Display size: 34 × 128 pixels.

34 × 128 pixel matrix driver

PCF8531



The host microprocessor/microcontroller and the PCF8531 are both connected to the I<sup>2</sup>C-bus. The SDA and SCL lines must be connected to the positive power supply via pull-up resistors. The internal oscillator requires no external components. The appropriate intermediate biasing voltage for the multiplexed LCD waveforms are generated on-chip. The only other connections required to complete the system are to the power supplies ( $V_{DD}$ ,  $V_{SS}$  and  $V_{LCD}$ ) and suitable capacitors for decoupling  $V_{LCD}$  and  $V_{DD}$ .





## 34 × 128 pixel matrix driver

## PCF8531

## 15 BONDING PAD LOCATIONS

**Table 10** Bonding pad locations

All x and y coordinates are referenced to the centre of the chip (dimensions in  $\mu\text{m}$ ; see Fig.28).

SYMBOL	PAD	x	y
dummy	1	+5973.6	-821.7
dummy	2	+5969.5	+823.4
dummy	3	+5899.5	+823.4
dummy	4	+5829.5	+823.4
dummy	5	+5479.5	+823.4
dummy	6	+5409.5	+823.4
dummy	7	+5059.5	+823.4
dummy	8	+4989.5	+823.4
dummy	9	+4639.5	+823.4
dummy	10	+4569.5	+823.4
dummy	11	+4219.5	+823.4
dummy	12	+4149.5	+823.4
dummy	13	+3799.5	+823.4
dummy	14	+3729.5	+823.4
OSC	15	+3449.5	+823.4
V <sub>LCDSENSE</sub>	16	+3169.5	+823.4
V <sub>LCDOUT</sub>	17	+3099.5	+823.4
V <sub>LCDOUT</sub>	18	+3029.5	+823.4
V <sub>LCDOUT</sub>	19	+2959.5	+823.4
V <sub>LCDOUT</sub>	20	+2889.5	+823.4
V <sub>LCDOUT</sub>	21	+2819.5	+823.4
V <sub>LCDOUT</sub>	22	+2749.5	+823.4
V <sub>LCDOUT</sub>	23	+2679.5	+823.4
V <sub>LCDIN</sub>	24	+2539.5	+823.4
V <sub>LCDIN</sub>	25	+2469.5	+823.4
V <sub>LCDIN</sub>	26	+2399.5	+823.4
V <sub>LCDIN</sub>	27	+2329.5	+823.4
V <sub>LCDIN</sub>	28	+2259.5	+823.4
V <sub>LCDIN</sub>	29	+2189.5	+823.4
V <sub>LCDIN</sub>	30	+2119.5	+823.4
RES	31	+1979.5	+823.4
V <sub>DD3</sub>	32	+1699.5	+823.4
V <sub>DD3</sub>	33	+1629.5	+823.4
V <sub>DD3</sub>	34	+1559.5	+823.4
V <sub>DD2</sub>	35	+1279.5	+823.4
V <sub>DD2</sub>	36	+1209.5	+823.4
V <sub>DD2</sub>	37	+1139.5	+823.4

SYMBOL	PAD	x	y
V <sub>DD2</sub>	38	+1069.5	+823.4
V <sub>DD2</sub>	39	+999.5	+823.4
V <sub>DD2</sub>	40	+929.5	+823.4
V <sub>DD2</sub>	41	+859.5	+823.4
V <sub>DD2</sub>	42	+789.5	+823.4
V <sub>DD1</sub>	43	+649.5	+823.4
V <sub>DD1</sub>	44	+579.5	+823.4
V <sub>DD1</sub>	45	+509.5	+823.4
V <sub>DD1</sub>	46	+439.5	+823.4
V <sub>DD1</sub>	47	+369.5	+823.4
V <sub>DD1</sub>	48	+299.5	+823.4
V <sub>DD1</sub>	49	+229.5	+823.4
SDA	50	+19.5	+823.4
SDA	51	-50.5	+823.4
SDACK	52	-400.5	+823.4
dummy	53	-750.5	+823.4
SA0	54	-820.5	+823.4
ENR	55	-1100.5	+823.4
T4	56	-1380.5	+823.4
V <sub>SS2</sub>	57	-1660.5	+823.4
V <sub>SS2</sub>	58	-1730.5	+823.4
V <sub>SS2</sub>	59	-1800.5	+823.4
V <sub>SS2</sub>	60	-1870.5	+823.4
V <sub>SS2</sub>	61	-1940.5	+823.4
V <sub>SS2</sub>	62	-2010.5	+823.4
V <sub>SS2</sub>	63	-2080.5	+823.4
V <sub>SS1</sub>	64	-2220.5	+823.4
V <sub>SS1</sub>	65	-2290.5	+823.4
V <sub>SS1</sub>	66	-2360.5	+823.4
V <sub>SS1</sub>	67	-2430.5	+823.4
V <sub>SS1</sub>	68	-2500.5	+823.4
V <sub>SS1</sub>	69	-2570.5	+823.4
V <sub>SS1</sub>	70	-2640.5	+823.4
T3	71	-2780.5	+823.4
T1	72	-3060.5	+823.4
SCL	73	-3410.5	+823.4
SCL	74	-3480.5	+823.4
dummy	75	-3830.5	+823.4
dummy	76	-4180.5	+823.4
dummy	77	-4530.5	+823.4
T2	78	-4600.5	+823.4

## 34 × 128 pixel matrix driver

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SYMBOL	PAD	x	y
dummy	79	-4880.5	+823.4
dummy	80	-4950.5	+823.4
dummy	81	-5230.5	+823.4
dummy	82	-5300.5	+823.4
dummy	83	-5650.5	+823.4
dummy	84	-5720.5	+823.4
dummy	85	-5930.5	+823.4
dummy	86	-5926.4	-821.7
R0	87	-5786.4	-821.7
R2	88	-5716.4	-821.7
R4	89	-5646.4	-821.7
R6	90	-5576.4	-821.7
R8	91	-5506.4	-821.7
R10	92	-5436.4	-821.7
R12	93	-5366.4	-821.7
R14	94	-5296.4	-821.7
R16	95	-5226.4	-821.7
R18	96	-5156.4	-821.7
R20	97	-5086.4	-821.7
R22	98	-5016.4	-821.7
R24	99	-4946.4	-821.7
R26	100	-4876.4	-821.7
R28	101	-4806.4	-821.7
R30	102	-4736.4	-821.7
R32	103	-4666.4	-821.7
C0	104	-4526.4	-821.7
C1	105	-4456.4	-821.7
C2	106	-4386.4	-821.7
C3	107	-4316.4	-821.7
C4	108	-4246.4	-821.7
C5	109	-4176.4	-821.7
C6	110	-4106.4	-821.7
C7	111	-4036.4	-821.7
C8	112	-3966.4	-821.7
C9	113	-3896.4	-821.7
C10	114	-3826.4	-821.7
C11	115	-3756.4	-821.7
C12	116	-3686.4	-821.7
C13	117	-3616.4	-821.7
C14	118	-3546.4	-821.7
C15	119	-3476.4	-821.7

SYMBOL	PAD	x	y
C16	120	-3406.4	-821.7
C17	121	-3336.4	-821.7
C18	122	-3266.4	-821.7
C19	123	-3196.4	-821.7
C20	124	-3126.4	-821.7
C21	125	-3056.4	-821.7
C22	126	-2986.4	-821.7
C23	127	-2916.4	-821.7
C24	128	-2846.4	-821.7
C25	129	-2776.4	-821.7
C26	130	-2706.4	-821.7
C27	131	-2636.4	-821.7
C28	132	-2566.4	-821.7
C29	133	-2496.4	-821.7
C30	134	-2426.4	-821.7
C31	135	-2356.4	-821.7
C32	136	-2286.4	-821.7
C33	137	-2216.4	-821.7
C34	138	-2146.4	-821.7
C35	139	-2076.4	-821.7
C36	140	-2006.4	-821.7
C37	141	-1936.4	-821.7
C38	142	-1866.4	-821.7
C39	143	-1796.4	-821.7
C40	144	-1726.4	-821.7
C41	145	-1656.4	-821.7
C42	146	-1586.4	-821.7
C43	147	-1516.4	-821.7
C44	148	-1446.4	-821.7
C45	149	-1376.4	-821.7
C46	150	-1306.4	-821.7
C47	151	-1236.4	-821.7
C48	152	-1166.4	-821.7
C49	153	-1096.4	-821.7
C50	154	-1026.4	-821.7
C51	155	-956.4	-821.7
C52	156	-886.4	-821.7
C53	157	-816.4	-821.7
C54	158	-746.4	-821.7
C55	159	-676.4	-821.7
C56	160	-606.4	-821.7

## 34 × 128 pixel matrix driver

## PCF8531

SYMBOL	PAD	x	y
C57	161	-466.4	-821.7
C58	162	-396.4	-821.7
C59	163	-326.4	-821.7
C60	164	-256.4	-821.7
C61	165	-186.4	-821.7
C62	166	-116.4	-821.7
C63	167	-46.4	-821.7
C64	168	+93.6	-821.7
C65	169	+163.6	-821.7
C66	170	+233.6	-821.7
C67	171	+303.6	-821.7
C68	172	+373.6	-821.7
C69	173	+443.6	-821.7
C70	174	+513.6	-821.7
C71	175	+583.6	-821.7
C72	176	+653.6	-821.7
C73	177	+723.6	-821.7
C74	178	+793.6	-821.7
C75	179	+863.6	-821.7
C76	180	+933.6	-821.7
C77	181	+1003.6	-821.7
C78	182	+1073.6	-821.7
C79	183	+1143.6	-821.7
C80	184	+1213.6	-821.7
C81	185	+1283.6	-821.7
C82	186	+1353.6	-821.7
C83	187	+1423.6	-821.7
C84	188	+1493.6	-821.7
C85	189	+1563.6	-821.7
C86	190	+1633.6	-821.7
C87	191	+1703.6	-821.7
C88	192	+1773.6	-821.7
C89	193	+1843.6	-821.7
C90	194	+1913.6	-821.7
C91	195	+1983.6	-821.7
C92	196	+2053.6	-821.7
C93	197	+2123.6	-821.7
C94	198	+2193.6	-821.7
C95	199	+2263.6	-821.7
C96	200	+2403.6	-821.7
C97	201	+2473.6	-821.7

SYMBOL	PAD	x	y
C98	202	+2543.6	-821.7
C99	203	+2613.6	-821.7
C100	204	+2683.6	-821.7
C101	205	+2753.6	-821.7
C102	206	+2823.6	-821.7
C103	207	+2893.6	-821.7
C104	208	+2963.6	-821.7
C105	209	+3033.6	-821.7
C106	210	+3103.6	-821.7
C107	211	+3173.6	-821.7
C108	212	+3243.6	-821.7
C109	213	+3313.6	-821.7
C110	214	+3383.6	-821.7
C111	215	+3453.6	-821.7
C112	216	+3523.6	-821.7
C113	217	+3593.6	-821.7
C114	218	+3663.6	-821.7
C115	219	+3733.6	-821.7
C116	220	+3803.6	-821.7
C117	221	+3873.6	-821.7
C118	222	+3943.6	-821.7
C119	223	+4013.6	-821.7
C120	224	+4083.6	-821.7
C121	225	+4153.6	-821.7
C122	226	+4223.6	-821.7
C123	227	+4293.6	-821.7
C124	228	+4363.6	-821.7
C125	229	+4433.6	-821.7
C126	230	+4503.6	-821.7
C127	231	+4573.6	-821.7
R33	232	+4713.6	-821.7
R31	233	+4783.6	-821.7
R29	234	+4853.6	-821.7
R27	235	+4923.6	-821.7
R25	236	+4993.6	-821.7
R23	237	+5063.6	-821.7
R21	238	+5133.6	-821.7
R19	239	+5203.6	-821.7
R17	240	+5343.6	-821.7
R15	241	+5413.6	-821.7
R13	242	+5483.6	-821.7

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SYMBOL	PAD	x	y
R11	243	+5553.6	-821.7
R9	244	+5623.6	-821.7
R7	245	+5693.6	-821.7
R5	246	+5763.6	-821.7
R3	247	+5833.6	-821.7
R1	248	+5903.6	-821.7

Table 11 Bonding pads

PAD	SIZE	UNIT
Pad pitch	min. 70	μm
Pad size; Al	62 × 100	μm
Bump dimensions	50 × 90 × 17.5 (±5)	μm
Wafer thickness (excluding bumps)	381	μm

Table 12 Alignment marks

MARKS	x	y
C1	-5402.0	+823.1
C2	+5292.4	+823.4
F	+5890.3	+401.9
Circle 1	-5543.0	+798.4
Circle 2	+5637.4	+798.4

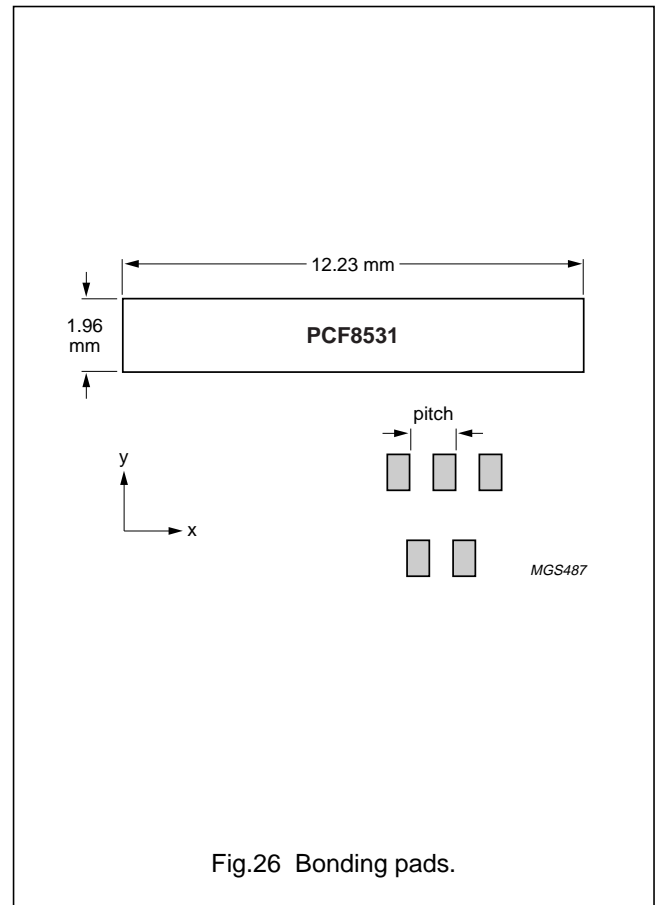


Fig.26 Bonding pads.

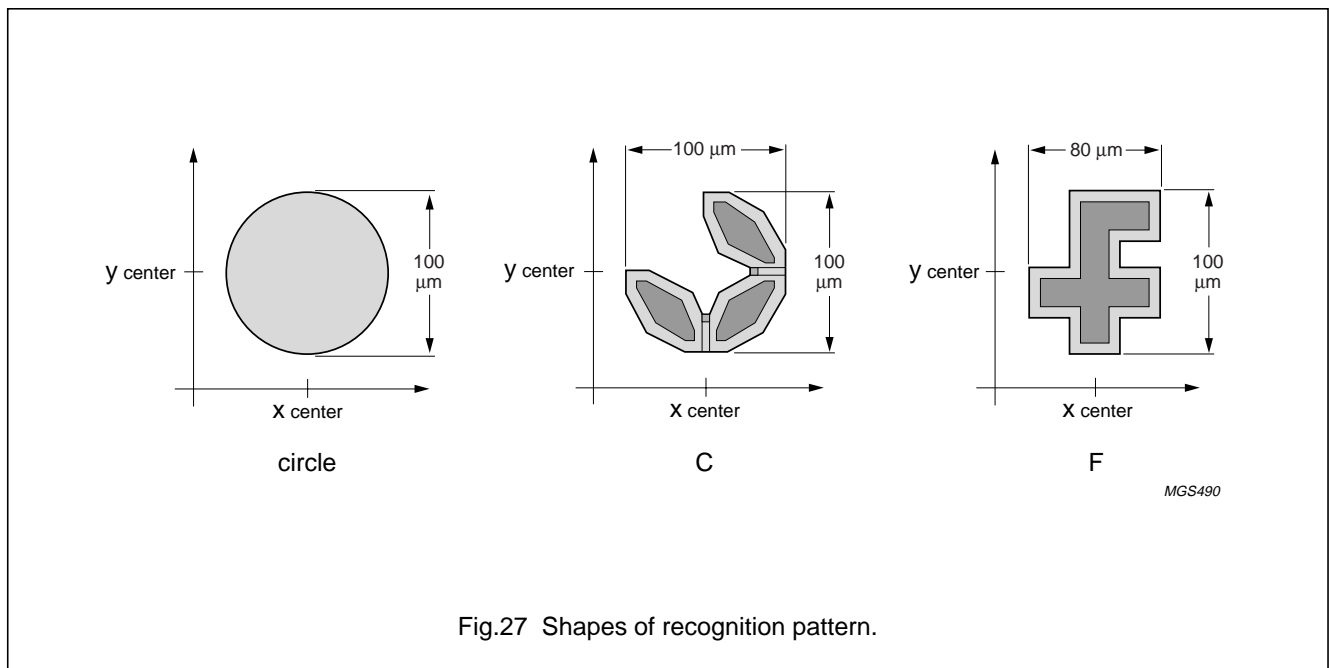
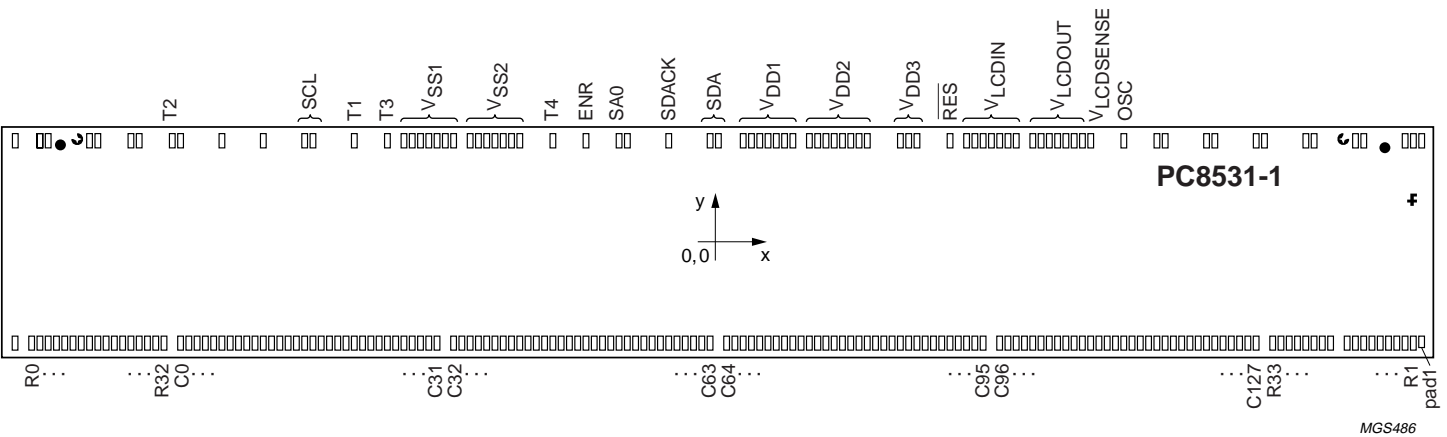


Fig.27 Shapes of recognition pattern.

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The positioning of the bonding pads is not to scale.

Fig.28 Bonding pad location.

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16 DEVICE PROTECTION DIAGRAM

For all diagrams: the maximum forward current is 5 mA and the maximum reverse voltage is 5 V.

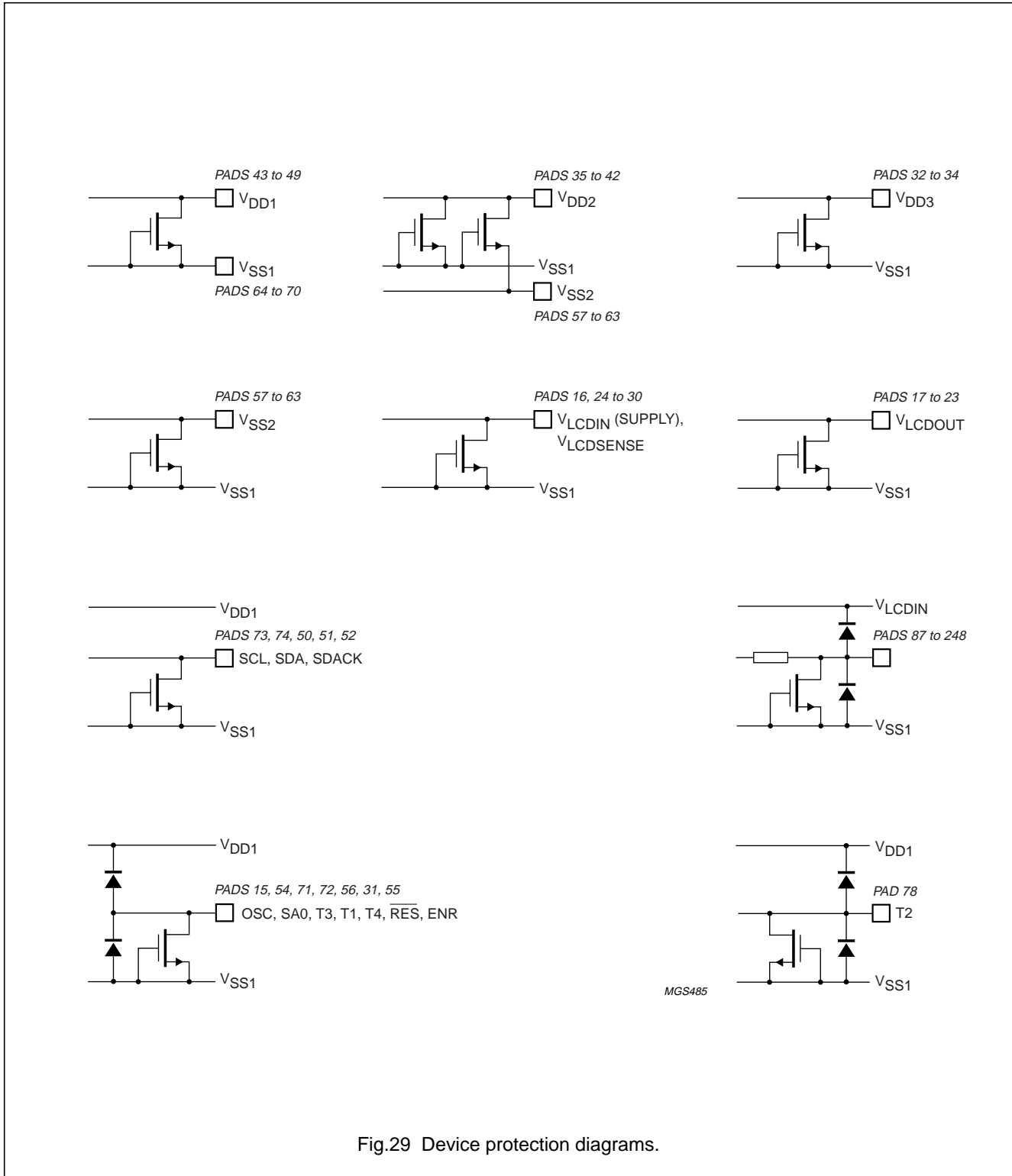
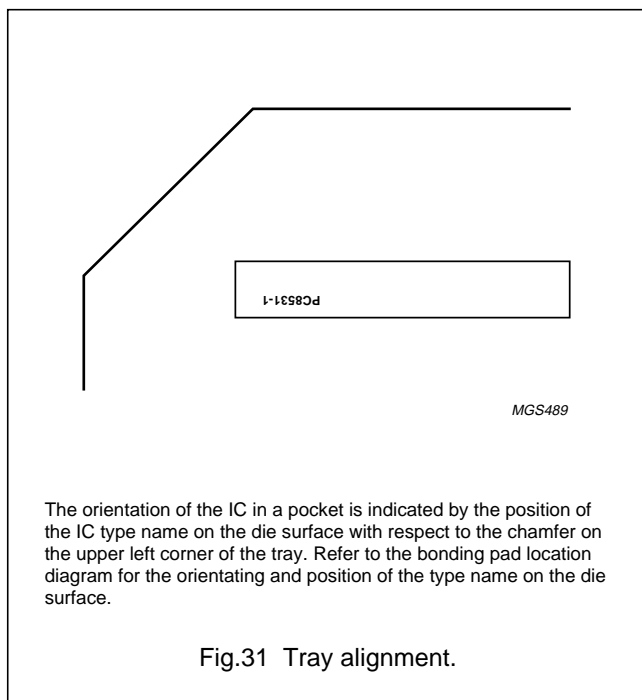
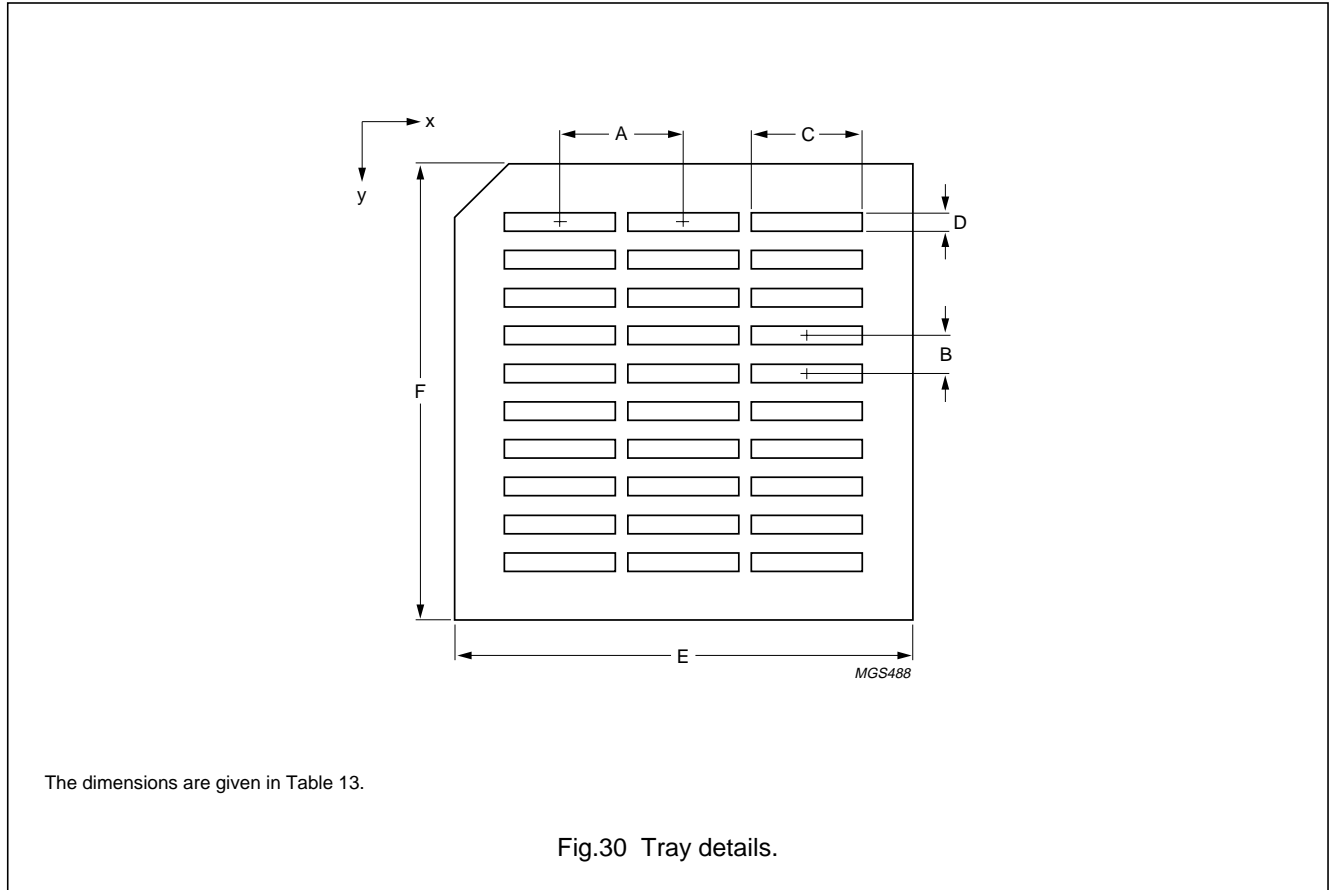


Fig.29 Device protection diagrams.

34 × 128 pixel matrix driver

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17 TRAY INFORMATION



**Table 13** Dimensions

DIM.	DESCRIPTION	VALUE
A	pocket pitch; x direction	13.72 mm
B	pocket pitch; y direction	4.17 mm
C	pocket width; x direction	12.34 mm
D	pocket width; y direction	2.05 mm
E	tray width; x direction	50.8 mm
F	tray width; y direction	50.8 mm
x	number of pockets in x direction	3
y	number of pockets in y direction	10

## 34 × 128 pixel matrix driver

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**18 DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

**19 LIFE SUPPORT APPLICATIONS**

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

**20 PURCHASE OF PHILIPS I<sup>2</sup>C COMPONENTS**

Purchase of Philips I<sup>2</sup>C components conveys a license under the Philips' I<sup>2</sup>C patent to use the components in the I<sup>2</sup>C system provided the system conforms to the I<sup>2</sup>C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.



34 × 128 pixel matrix driver

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**NOTES**

34 × 128 pixel matrix driver

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**NOTES**

34 × 128 pixel matrix driver

PCF8531

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**NOTES**

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